# Rockchip RK3308B-S Datasheet

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**Revision History** 

Date	Revision	Description
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## **Chapter 1 Introduction**

#### 1.1 Overview

RK3308B-S is a high-performance Quad-core application processor designed for intelligent voice interaction, audio input/output processing, and other digital multimedia applications. Embedded rich audio interfaces, such as I2S, PCM, TDM, PDM, SPDIF, HDMI ARC and so on, can meet different audio application development, reduce hardware development complexity and development cost.

Embedded Voice Activity Detection function will monitor human voice at any time, respond to human voice request timely and fast setup intelligent voice interaction application, which will also reduce hardware system power consumption and improve battery endurance. RK3308B-S has high-performance external memory interface

(DDR2/DDR3/DDR3L/LPDDR2) capable of sustaining demanding memory bandwidths. 64MB DDR2 die is embedded for RK3308H-S.

#### 1.2 Features

The features listed below which may or may not be present in actual product, may be subject to the third party licensing requirements. Please contact Rockchip for actual product feature configurations and licensing requirements.

#### 1.2.1 Microprocessor

- Quad-core ARM Cortex-A35 CPU
- ARM architecture v8-A instruction set
- ARM Neon Advanced SIMD (single instruction, multiple data) support for accelerated media and signal processing computation
- ARMv8 Cryptography Extensions
- 256KB unified system L2 cache
- Include VFP v4 hardware to support single and double-precision operations
- Integrated 32KB L1 instruction cache, 32KB L1 data cache with 4-way set associative
- TrustZone technology support
- Separate power domains for CPU core system to support internal power switch and externally turn on/off based on different application scenario
  - PD A35 0: 1st Cortex-A35 + Neon + FPU + L1 I/D Cache
  - PD A35 1: 2nd Cortex-A35 + Neon + FPU + L1 I/D Cache
  - PD A35 2: 3rd Cortex-A35 + Neon + FPU + L1 I/D Cache
  - PD A35 3: 4th Cortex-A35 + Neon + FPU + L1 I/D Cache
- One isolated voltage domain to support DVFS

#### 1.2.2 Memory Organization

- Internal on-chip memory
  - BootROM
  - Internal SRAM
- External off-chip memory<sup>®</sup>
  - DDR2/DDR3/DDR3L/LPDDR2
  - 8bits Asynchronism Nand Flash
  - eMMC
  - SPI Nor/Nand Flash
  - SD Card

#### 1.2.3 Internal Memory

- Internal BootRom
  - Support system boot from the following device:
    - Asynchronism Nand Flash
    - eMMC interface
    - SPI Flash interface

- ◆ SDMMC interface
- Support system code download by the following interface:
  - ◆ USB OTG interface (Device mode)
- Internal SRAM
  - Size: 256KB
- RK3308H-S embedded with 64MB DDR2

#### 1.2.4 External Memory or Storage device

- Dynamic Memory Interface (DDR2/DDR3/DDR3L/LPDDR2)
  - Compatible with JEDEC standards
  - Compatible with DDR2-1066/DDR3-1600/DDR3L-1600/LPDDR2-1066
  - Support 16-bit data width
  - Support 1 ranks (chip selects)
  - Support max 512MB addressing space
  - Low power modes, such as power-down and self-refresh for SDRAM
- Nand Flash Interface
  - Support Asynchronism Nand flash
  - Data bus width is 8bits
  - Support 1 chip select
  - Up to 16bits/1KB hardware ECC
- eMMC Interface
  - Compatible with standard iNAND interface
  - Compatible with eMMC specification 4.41, 4.51, 5.0 and 5.1
  - Support three data bus width: 1-bit, 4-bit or 8-bit
  - Support up to HS200; but not support CMD Queue
- Serial Flash Interface
  - Support transfer data from/to SPI flash device
  - Support x1,x2,x4 data bits mode
  - Support up to 1 chip select
- SD/MMC Interface
  - Compatible with SD3.0, MMC ver4.51
  - Data bus width is 4bits

#### 1.2.5 System Component

- CRU (clock & reset unit)
  - One oscillator with 24MHz clock input
  - Support clock gating control for individual components
  - Support global soft-reset control for whole chip, also individual soft-reset for each component
- PMU(power management unit)
  - 2 separate voltage domains(CORE\_VDD/LOGIC\_VDD)
  - 4 separate cpu power domains, which can be power up/down by software based on different application scenes
  - Multiple configurable work modes to save power by different frequency or automatic clock gating control or power domain on/off control
- Timer
  - Six 64bits timers with interrupt-based operation for non-secure application
  - Six 64bits timers with interrupt-based operation for secure application
  - Support two operation modes: free-running and user-defined count

■ Support timer work state checkable

#### PWM

- Three on-chip 4-channels PWM controllers with interrupt-based operation
- Programmable pre-scaled operation to bus clock and then further scaled
- Embedded 32-bit timer/counter facility
- Support capture mode
- Provides reference mode and output various duty-cycle waveform
- Support continuous mode or one-shot mode
- Optimized for IR application for last channel of each PWM controller

#### Watchdog

- 32-bit watchdog counter
- Counter counts down from a preset value to 0 to indicate the occurrence of a timeout
- WDT can perform two types of operations when timeout occurs:
  - Generate a system reset
  - ◆ First generate an interrupt and if this is not cleared by the service routine by the time a second timeout occurs then generate a system reset
- Programmable reset pulse length
- Totally 16 defined-ranges of main timeout period

#### Interrupt Controller

- Support 4 PPI interrupt source and 89 SPI interrupt sources input from different components
- Support 16 software-triggered interrupts
- Two interrupt outputs (nFIQ and nIRQ) separately for each Cortex-A35, both are low-level sensitive
- Support different interrupt priority for each interrupt source, and they are always software-programmable

#### DMAC

- Micro-code programming based DMA
- The specific instruction set provides flexibility for programming DMA transfers
- Linked list DMA function is supported to complete scatter-gather transfer
- Support internal instruction cache
- Embedded DMA manager thread
- Support data transfer types with memory-to-memory, memory-to-peripheral, peripheral-to-memory
- Signals the occurrence of various DMA events using the interrupt output signals
- Mapping relationship between each channel and different interrupt outputs is software-programmable
- Two embedded DMA controllers for peripheral system
- DMAC0 features,
  - 6 channels in total
  - ◆ 10 hardware request from peripherals
    - 2 interrupt output
  - Dual APB slave interface for register configuration, designated as secure and non-secure
  - Support TrustZone technology and programmable secure state for each DMA channel
- DMAC1 features,
  - ♦ 8 channels in total
  - ◆ 20 hardware request from peripherals
  - ◆ 2 interrupt output
  - Dual APB slave interface for register configuration, designated as secure and non-secure

- Support TrustZone technology and programmable secure state for each DMA channel
- Trust Execution Environment system
  - Support TrustZone technology for the following components
    - ◆ Cortex-A35, support secure and non-secure mode, switch by software
    - ◆ System general DMAC, support dedicated channels work only in secure mode
    - ◆ Secure OTP, only can be accessed by Cortex-A35 in secure mode and secure key reader block
    - ◆ Internal SRAM, part of space is addressed only in secure mode, detailed size is software-programmable together with TZMA (TrustZone memory adapter)
    - ◆ Firewall is embedded to manage the other master/slave function components
  - Cipher engine
    - ◆ Support SHA-1, SHA-256/224, SHA-512/384, MD5 with hardware padding
    - ◆ Support HMAC of SHA-1, SHA-256, SHA-512, MD5 with hardware padding
    - ◆ Support AES-128, AES-192, AES-256 encrypt & decrypt cipher
    - ◆ Support DES & TDES cipher
    - ◆ Support AES ECB/CBC/OFB/CFB/CTR/CTS/XTS/CCM/GCM/CBC-MAC/CMAC mode
    - ◆ Support DES/TDES ECB/CBC/OFB/CFB mode
    - ◆ Support up to 4096 bits PKA mathematical operations for RSA/ECC
  - Support data scrambling for DDR2/DDR3/DDR3L/LPDDR2
  - Support up to 256 bits TRNG output
  - Support secure OTP
  - Support secure debug
  - Support secure OS

#### 1.2.6 Video Output Processor (VOP)

- Display Interface
  - Support parallel RGB LCD output interface
    - ◆ 24-bit(RGB888)
    - ◆ 18-bit(RGB666)
    - ◆ 16-bit(RGB565)
  - Support MCU interface
  - Max output resolution is 1080p
- Display process
  - Background layer: programmable 24-bit color
  - Win0 layer
    - ◆ RGB888, ARGB888, RGB565, YCbCr422, YCbCr420, YCbCr444
    - ◆ RB/alpha/mid/uv swap
    - ♦ 1/8 to 8 scaling-down and scaling-up engine
    - ♦ Support virtual display
    - ◆ 256 level alpha blending (pre-multiplied alpha support)
    - Transparency color key
    - YCbCr2RGB(rec601-mpeg/rec601-jpeg/rec709)
    - ◆ RGB2YCbCr(BT601/BT709)
  - Win1 layer
    - ◆ RGB888, ARGB888, RGB565
    - ♦ RB/alpha/endian swap
    - Support virtual display
    - ◆ 256 level alpha blending (pre-multiplied alpha support)
    - ◆ Transparency color key
    - ◆ RGB2YCbCr(BT601/BT709)
- Others
  - Win0 layer and Win1 layer overlay exchangeable
  - BCSH(Brightness, Contrast, Saturation, Hue adjustment)

- BCSH:YCbCr2RGB(rec601-mpeg/rec601-jpeg/rec709)
- BCSH:RGB2YCbCr(BT601/BT709)
- Support Gamma adjust for PAD
- Support dither down allegro RGB888to666 RGB888to565 & dither down frc (configurable ) RGB888to666
- Blank and black display
- Standby mode
- Support RB/RG/BG/delta/dummy swap

#### 1.2.7 Audio Interface

- I2S with 2 channel
  - Support 2 I2S\_2CH components
  - I2S\_2CH\_0 support master tx/rx mode and slave tx/rx mode
  - I2S\_2CH\_0 connects to chip IO
  - I2S\_2CH\_1 support slave rx mode
  - I2S\_2CH\_1 connects with audio codec inside chip
  - Support I2S normal, left and right justified mode serial audio data transfer
  - Support PCM early, late1, late2, late3 mode serial audio data transfer
  - Support resolution from 16bits to 32bits
  - Sample rate up to 192KHz
  - Support DMA transfer
  - Support separate transmit and receive DMA request mode
  - Support 1 common SCLK signal for receiving and transmitting
  - Support 1 common LRCK signal for receiving and transmitting
  - Support 2 independent LRCK signals for receiving and transmitting
  - Support configurable SCLK and LRCK polarity

#### I2S with 8 channel

- Support 4 I2S\_8CH components
- I2S\_8CH\_0 support master tx/rx mode and slave tx/rx mode
- I2S\_8CH\_1 support master tx/rx mode and slave tx/rx mode
- I2S 8CH 0/1 connect to chip IO
- I2S 8CH 0 support max 8ch in and max 8ch out simultaneously
- I2S\_8CH\_1 support tx plus rx max 10ch simultaneously
- I2S\_8CH\_2 support master tx/rx mode and slave tx/rx mode
- I2S\_8CH\_3 support slave rx mode, can only works as 4CH mode
- I2S\_8CH\_2/3 connect with audio codec inside chip
- Support I2S normal, left and right justified mode serial audio data transfer
- Support PCM early, late1, late2, late3 mode serial audio data transfer
- Support resolution from 16bits to 32bits
- Sample rate up to 192KHz
- Support DMA transfer
- Support separate transmit and receive DMA request mode
- Support 1 common SCLK signal for receiving and transmitting
- Support 2 independent SCLK signals for receiving and transmitting
- Support 1 common LRCK signal for receiving and transmitting
- Support 2 independent LRCK signals for receiving and transmitting
- Support configurable SCLK and LRCK polarity

#### I2S with 16 channel

- Support one I2S 16CH by gathering I2S 8CH 0 and I2S 8CH 1
- Support master tx/rx mode and slave tx/rx mode

#### PDM with 8 channel

- Support PDM master receive mode
- Support 5 wire PDM interface with one is clock and 4 data line
- Support up to 8 mono microphones or 4 stereo microphones

- Support each data path is enabled or disabled independently
- Support DMA handshaking interface and configurable DMA water level
- Support 16~24 bit sample resolution
- Support sample rate up to 192KHz
- Support programmable data sampling sensibility, rising or falling edge

#### TDM with 8 channel

- Support 4 TDM\_8CH, share same I2S\_8CH controller accordingly
- Support I2S normal, left and right justified mode serial audio data transfer
- Support PCM normal, 1/2 cycle left shift, 1 cycle left shift, 3/2 cycle left shift, 2 cycle left shift mode serial audio data transfer
- Support TDM programmable slot bit width: 16~32bits
- Support TDM programmable frame width: 32~512bits
- Support TDM programmable FSYNC width
- Sample rate up to 192KHz@2CH and 48KHz@8CH
- Support DMA transfer
- Support separate transmit and receive DMA request mode
- Support 1 common SCLK signal for receiving and transmitting
- Support 2 independent SCLK signals for receiving and transmitting
- Support 1 common LRCK signal for receiving and transmitting
- Support 2 independent LRCK signals for receiving and transmitting
- Support configurable SCLK and LRCK polarity

#### SPDIF

- Support SPDIF TX x 1
- Support SPDIF RX x 1
- Support HDMI ARC
- Support 16bits/20bits/24bits resolution
- Support DMA transfer
- Support linear PCM mode (IEC-60958)
- Support non-linear PCM transfer(IEC-61937)
- Sample rate up to 192KHz
- Support SPDIF RX is bypassed to SPDIF TX directly

#### Voice Activity Detection(VAD)

- Support single Mic human voice detection
- Support human voice frequency band filtering
- Support human voice amplitude detection
- Support Muti-Mic array data store before voice detection event or after voice detection event two modes, and also can support Muti-Mic array data is not stored in voice detection process
- Support Mic data from Analog Mic, I2S Digital Mic or PDM digital Mic
- Store memory is shared with system internal memory

#### Embedded Audio Codec

- 24 bit DAC which support stereo headphone out and line out
- 24 bit ADC which support max 8 channel microphone input
- Support differential microphone input and can also be configured as single-end
- Support Po=18mW for 16ohm and 9mW for 32ohm headphone output
- Support Automatic Level Control (ALC)
- Support programmable input/output analog gains
- Support two programmable microphone bias. The max programmable voltage can reach to 0.85\*AVDD3V3
- Support I2S as the digital signal interface for both ADC and DAC
- Support both master and slave mode
- Support 16bits/24bits resolution
- Support I2S normal, left and right justified mode
- Support sample rate,

- Group1: 8khz,16khz,32kHz,64kHz,128khz
- Group2: 11.025khz,22.05khz,44.1khz,88.2khz,176.4khz
- Group3: 12khz,24khz,48khz,96khz,192khz
- ◆ Support ADC/DAC sample rate any combination of group1/group2/group3
- Support headphone jack detection input

#### 1.2.8 Connectivity

- SDIO interface
  - Compatible with SDIO3.0 protocol
  - 4bits data bus widths
- MAC 10/100 Ethernet Controller
  - Supports 10/100-Mbps data transfer rates with the RMII interfaces
  - Supports both full-duplex and half-duplex operation
  - Supports IEEE 802.1Q VLAN tag detection for reception frames
  - Support detection of LAN wake-up frames and AMD Magic Packet frames
  - Handles automatic retransmission of Collision frames for transmission
- USB 2.0 OTG
  - Compatible with USB 2.0 specification
  - Supports high-speed(480Mbps), full-speed(12Mbps) and low-speed(1.5Mbps) mode
- USB 2.0 Host
  - Compatible with USB 2.0 specification
  - Supports high-speed(480Mbps), full-speed(12Mbps) and low-speed(1.5Mbps) mode
  - Support Enhanced Host Controller Interface Specification (EHCI), Revision 1.0
  - Support Open Host Controller Interface Specification (OHCI), Revision 1.0a
- SPI interface
  - Support three SPI Controller(SPI0/SPI1/SPI2)
  - Support one chip-select for each SPI Controller
  - Support serial-master and serial-slave mode, software-configurable
- I2C interface
  - Support four I2C interface(I2C0/I2C1/I2C2/I2C3)
  - Support 7bits and 10bits address mode
  - Software programmable clock frequency
  - Data on the I2C-bus can be transferred at rates of up to 100 kbit/s in the Standard-mode, up to 400 kbit/s in the Fast-mode or up to 1 Mbit/s in Fast-mode Plus
- UART Controller
  - Support five UART interface(UART0/UART1/UART2/UART3/UART4)
  - Embedded two 64-byte FIFO for TX and RX operation respectively
  - Support 5bit,6bit,7bit,8bit serial data transmit or receive
  - Standard asynchronous communication bits such as start, stop and parity
  - Support different input clock for UART operation to get up to 4Mbps baud rate
  - Support auto flow control mode for UART0/UART1/UART4

#### OWIRE Controller

- Support two internal 8-bit wide and 16-location deep FIFOs, one for transmitting and the other for receiving serial data
- Support three data transfer mode: bit mode, byte mode and bypass mode
- Support reset/presence detect sequence generate
- Time slots: write-1, write-0, read-1 and read-0
- RPP and write/read time slots are configurable
- Support clock divider to generate 1MHz base clock, and clock divide factor can be configured as 0~255

#### **1.2.9 Others**

- Multiple group of GPIO
  - All of GPIOs can be used to generate interrupt
  - Support level trigger and edge trigger interrupt
  - Support configurable polarity of level trigger interrupt
  - Support configurable rising edge, falling edge and both edge trigger interrupt
  - Support configurable pull direction(pullup or pulldown)
  - Support configurable drive strength
- Temperature Sensor(TS-ADC)
  - Up to 1KS/s sampling rate
  - Support one temperature sensor
  - -20~120°C temperature range and 5°C temperature resolution
- Successive Approximation ADC (SARADC)
  - 10-bit resolution
  - Up to 1MS/s sampling rate
  - 6 single-ended input channels
- OTP
  - Support 8K bit Size, 7K bit for secure application
  - Support Program/Read/Idle mode
- Package Type
  - RK3308B-S: TFBGA355 (body: 13mm x 13mm; ball size: 0.3mm; ball pitch: 0.65mm)
  - RK3308H-S: TFBGA355 (body: 14mm x 14mm; ball size: 0.3mm; ball pitch: 0.65mm)

#### Notes:

DDR2/DDR3/DDR3L/LPDDR2 are not used simultaneously

For RK3308H-S, 64MB DDR2 die is embedded, so there is no Dynamic Memory Interface. And RK3308H-S can be achieved the same PCB design with RK3308B-S.

## 1.3 Block Diagram

The following diagram shows the basic block diagram.

#### RK3308B-S

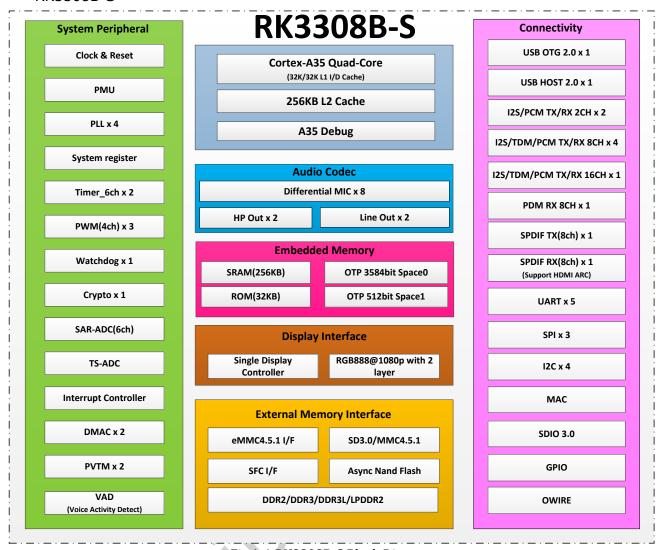


Fig.1-1 RK3308B-S Block Diagram

#### RK3308H-S

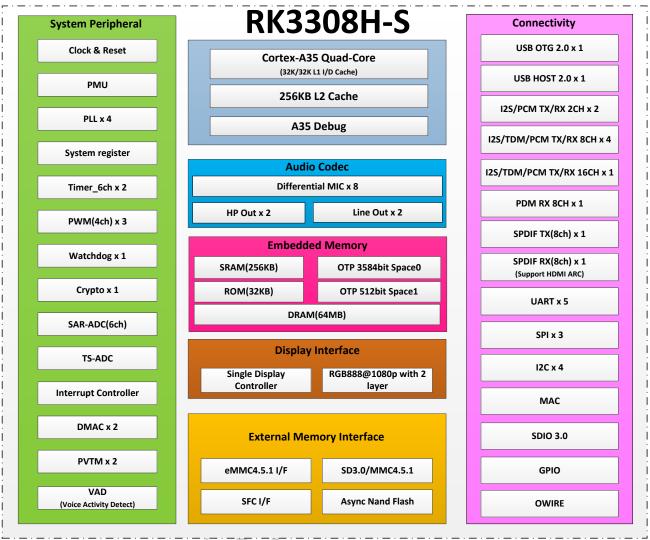


Fig.1-2 RK3308H-S Block Diagram

## **Chapter 2 Package Information**

#### 2.1 Order Information

Order Device	RoHS status	Package	Package Qty	Device Feature
RK3308B-S	RoHS	TFBGA355	1190 by tray	Quad core application processor
RK3308H-S	RoHS	TFBGA355	1190 by tray	Quad core application processor with 64MB DDR2

## 2.2 Top Marking

RK3308B-S

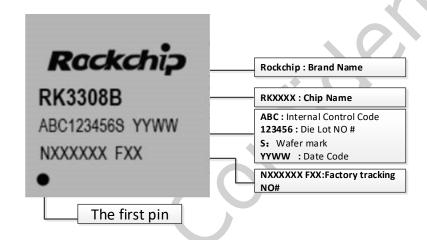


Fig.2-1 RK3308B-S Package definition

RK3308H-S

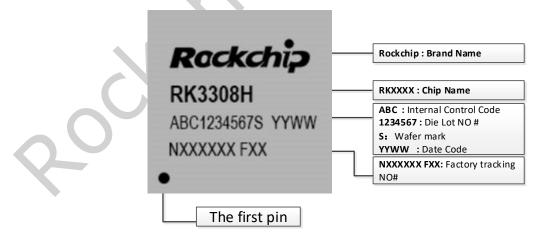


Fig.2-2 RK3308H-S Package definition

#### 2.3 TFBGA355 Dimension

#### RK3308B-S

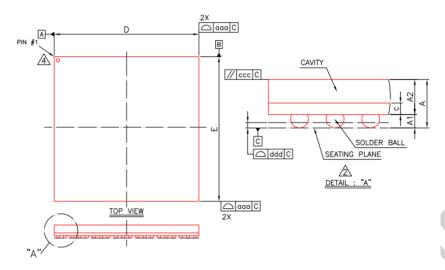


Fig.2-3 RK3308B-S Package Top View and Side View

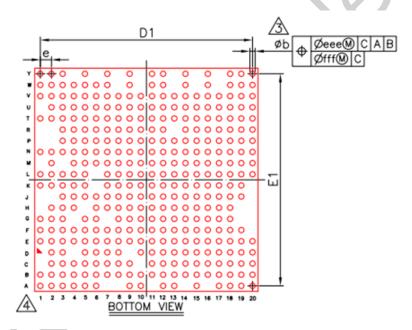


Fig.2-4 RK3308B-S Package bottom view

Symbol	Dimer	nsion ir	n mm	Dimer	sion in	inch	
Symbol	MIN	NOM	MAX	MIN	NOM	MAX	
Α	1.10	1.17	1.24	0.043	0.046	0.049	
A1	0.16	0.21	0.26	0.006	0.008	0.010	
A2	0.91	0.96	1.01	0.036	0.038	0.040	
С	0.22 0.26		0.30	0.009	0.010	0.012	
D	12.90	13.00	13.10	0.508	0.512	0.516	
E	12.90	13.00	13.10	0.508	0.512	0.516	
D1		12.35			0.486		
E1		12.35			0.486		
е		0.65			0.026		
b	0.26	0.31	0.36	0.010	0.012	0.014	
aaa		0.15		0.006			
ccc		0.20			0.008		
ddd		0.08			0.003		
eee		0.15		0.006			
fff		0.08		0.003			
MD/ME			20 /	/ 20			

Fig.2-5 RK3308B-S Package dimension

#### Notes:

- 1. CONTROLLING DIMENSION: MILLIMETER.
- 2. PRIMARY DATUM C AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.
- 3. DIMENSION b IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM C.
- 4. THE PATTERN OF PIN 1 FIDUCIAL IS FOR REFERENCE ONLY.
- 5. SPECIAL CHARACTERISTICS C CLASS: ccc, ddd
- 6. REFERANCE DOCUMENT: JEDEC PUBICATION 95 DESIGN GUIDE 4.5
- 7. PKG BALL DIAMETER IS 0.30+/-0.05 mm BEFORE REFLOW.

#### RK3308H-S

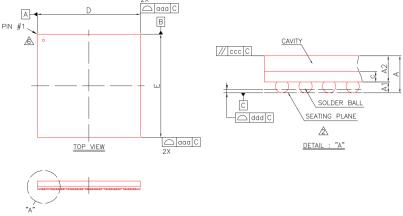


Fig.2-6 RK3308H-S Package Top View and Side View

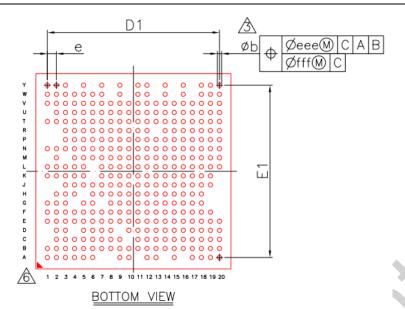


Fig.2-7 RK3308H-S Package bottom view

Symbol	Dimer	nsion ir	n mm	Dimer	nsion in	inch				
Syllibol	MIN	NOM	MAX	MIN	NOM	MAX				
Α	1.10	1.17	1.24	0.043	0.046	0.049				
A1	0.16	0.21	0.26	0.006	0.008	0.010				
A2	0.91	0.96	1.01	0.036	0.038	0.040				
С	0.22	0.26	0.30	0.009	0.010	0.012				
D	13.90	14.00	14.10	0.547	0.551	0.555				
E	13.90	14.00	14.10	0.547	0.551	0.555				
D1		12.35			0.486					
E1		12.35			0.486					
е		0.65			0.026					
b	0.26	0.31	0.36	0.010	0.012	0.014				
aaa		0.15			0.006					
ccc		0.20			0.008					
ddd		0.08			0.003					
eee		0.15		0.006						
fff		0.08		0.003						
MD/ME			20 /	/ 20						

Fig.2-8 RK3308H-S Package dimension

#### Notes:

- 1. CONTROLLING DIMENSION: MILLIMETER.
- 2. PRIMARY DATUM C AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.
- 3. DIMENSION b IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM C.
- 4. THE PATTERN OF PIN 1 FIDUCIAL IS FOR REFERENCE ONLY.
- 5. SPECIAL CHARACTERISTICS C CLASS: ccc, ddd
- 6. REFERANCE DOCUMENT: JEDEC PUBICATION 95 DESIGN GUIDE 4.5
- 7. PKG BALL DIAMETER IS 0.30+/-0.05 mm BEFORE REFLOW.

# 2.4 Ball Map

• RK3308B-S

	1	2	3	4	5	6	7	8	9	10
Α	VSS	DDR_A7	DDR_A2	VSS	DDR_A1	DDR_A6			VSS	DDR_A8
В	DDR_CS0N	DDR_BA0	DDR_A5	DDR_A0	DDR_A11	DDR_A12	DDR_A4	VSS	DDR_CKE	DDR_A14
С		DDR_CLKN	DDR_CLK	VSS	DDR_ODT0	VSS	VSS	DDR_BA1	DDR_A10	
D		VSS	DDR_DQ11		DDR_RASN	DDR_BA2	DDR_A13	DDR_CASN		FP_3
E	VSS	DDR_DQ4	DDR_DQ6	DDR_RESET	VSS	DDR_A3	DDR_A9	DDR_WEN	VSS	DDR_VDD
F	DDR_DQ5	VSS	DDR_DQ13	DDR_DQ8	FP_1	FP_2	DDR_VDD	DDR_VDD	DDR_VDD	LOGIC_VDD
G	DDR_DM0	DDR_DQ9	VSS		DDR_DQ1	DDR_VDD		VSS	VSS	LOGIC_VDD
Н		DDR_DQS1	DDR_DQS1N	DDR_DQ2		DDR_VDD	VSS	VSS	VSS	VSS
J			DDR_DQS0	DDR_DQ0	VSS	DDR_VDD	VSS	VSS	VSS	VSS
К	VSS	DDR_DQ7	VSS	DDR_DQS0N	DDR_DQ15		VSS	VSS	VSS	VSS

Fig.2-9 RK3308B-S Ball Map-1

L	DDR_D Q3	DDR_D Q12	DDR_ DM1	DDR_DQ1	VSS		VSS	VSS	VSS	VSS
М		DDR_D Q14		VSS	VSS	VSS	VSS	VSS	VSS	VSS
N	VSS	GPIO0_ C5/OTG _DRVB US	GPIO 0_A0/ SDIO _INT	GPIOO_A1 /SDIO_W RPT/PWM 4	VCCIO0	CORE_VDD	CORE_VDD	CORE_VDD	VSS	VSS
Р			GPIO 0_A2/ SDIO _PWR	GPIO0_A3 /SDMMC_ DET	CORE_VDD	CORE_VDD	CORE_VDD	VSS	VSS	VSS
R			GPIO 0_A4/ TEST _CLK OUT	GPIOO_A5	CORE_VDD	CORE_VDD	VSS	CORE_VDD	GPIO1_C4/LCDC _D16/I2S1_8CH_ SDO3_SDI1_M1/ PDM_8CH_SDI1_ M1/MAC_RXD0	GPIO3_B3/ FLASH_ALE /EMMC_PW REN/SPI1_ CLK/LCDC_ D23_M1
Т	GPIOO_ C1/SPD IF_TX/P WM5/U ART3_R X M1	GPIO0_ C4	GPIO 0_B0	GPIO0_A7	GPIO0_A6	GPIO1_B2/LC DC_D6/I2S1_ 8CH_SDO3_S DI1_M0/PDM_ 8CH_SDI1_M	VSS	GPIO1_B5/LCDC _D9/I2S1_8CH_S CLK_TX_M1/MAC _MDC	GPIO1_C7/UART 1_RTSN/UART2_ TX_M0/SPI2_MO SI/JTAG_TMS/LC DC_D19	GPIO1_D1/ UART1_TX/ I2C0_SCL/ SPI2_CSN0
U		GPIO0_ CO/PW M3/I2C 3_SCL_ M0	GPIO 0_B2/ TSAD C_SH UT	GPIO1_A2 /LCDC_VS YNC/I2S1 _8CH_MC LK_M0	GPIO1_A6/L CDC_D2/I2S 1_8CH_LRCK _RX_M0	GPIO1_B1/LC DC_D5/I2S1 8CH_SDO2_S DI2_M0/PDM_ 8CH_SDI2_M	GPIO1_B3/LCDC _D7/I2S1_8CH_ SDI0_M0/PDM_ 8CH_SDI0_M0	GPIO1_C2/LCDC _D14/I2S1_8CH_ SDO1_SDI3_M1/ PDM_8CH_SDI3_ M1/MAC_TXD0	GPIO1_C3/LCDC _D15/I2S1_8CH_ SD02_SDI2_M1/ PDM_8CH_SDI2_ M1/MAC_TXD1	GPIO3_A6/ FLASH_D6/ EMMC_D6/ LCDC_D18 _M1
<b>V</b>	GPIO0_ B4/I2C 1_SCL	GPIO0_ B3/I2C 1_SDA/ OWIRE _M0	GPIO 0_B5/ PWM0	GPIO1_A1 /LCDC_H SYNC	GPIO1_A5/L CDC_D1/I2S 1_8CH_LRCK _TX_M0	GPIO1_B0/LC DC_D4/I2S1_ 8CH_SDO1_S DI3_M0/PDM_ 8CH_SDI3_M	GPIO1_B4/LCDC _D8/I2S1_8CH_ MCLK_M1/MAC_ CLK	GPIO1_C1/LCDC _D13/I2S1_8CH_ SDO0_M1/MAC_T XEN	GPIO1_CO/LCDC _D12/I2S1_8CH_ LRCK_RX_M1/MA C_RXDV	GPIO1_D0/ UART1_RX/ I2CO_SDA/ SPI2_CLK
W	GPIOO_ B7/PW M2/I2C 3_SDA _M0	GPIO0_ B6/PW M1	GPIO 0_C2/ SPDIF _RX/P WM6/ UART 3_TX _M1	GPIO1_A3 /LCDC_DE N/I2S1_8 CH_SCLK _TX_M0	GPIO1_A4/L CDC_D0/I2S 1_8CH_SCLK _RX_M0/PDM _8CH_CLK_M 0	GPIO1_A7/LC DC_D3/I2S1_ 8CH_SD00_M 0	GPIO1_B6/LCDC _D10/I2S1_8CH _SCLK_RX_M1/P DM_8CH_CLK_M 1/MAC_MDIO		GPIO1_C6/UART 1_CTSN/UART2_ RX_M0/SPI2_MIS O/JTAG_TCK/OW IRE_M1/LCDC_D	
Y	VSS	GPIO0_ C3/RTC _CLK	GPIO 0_B1/ PMIC _SLEE		GPIO1_A0/L CDC_DCLK		GPIO1_B7/LCDC _D11/I2S1_8CH _LRCK_TX_M1/ MAC_RXER		GPIO1_C5/LCDC _D17/I2S1_8CH_ SDI0_M1/PDM_8 CH_SDI0_M1/MA	
	1	2	3	4	5	6	7	8	9	10

Fig.2-10 RK3308B-S Ball Map-2

11	12	13	14	15	16	17	18	19	20	_
	USB1_DM	USB0_DM		GPIO4_D3/ SDMMC_D3 /UART2_TX _M1		GPIO4_D1/ SDMMC_D1	ADC_IN3	ADC_IN0	VSS	А
VSS	USB1_DP	USB0_DP	GPIO4_D6/ SDMMC_PW REN	GPIO4_D2/ SDMMC_D2 /UART2_RX _M1	GPIO4_D5/ SDMMC_CL K	GPIO4_D0/ SDMMC_D0	ADC_IN4	ADC_IN1	NPOR	В
VSS	USB_ID	VSS	USB_VBUS	NC	GPIO4_D4/ SDMMC_CM D	VSS	ADC_IN2	NPOR_BYPA SS	REF_CLKOU T	С
VSS	VSS	USB_AVDD _3V3	VCCIO5	USB_VDD_0 V9	USB_AVDD _1V8	SADC_AVD D_1V8	ADC_IN5	TVSS	VSS	D
VSS	VSS	VSS	USB_AVDD _3V3	PLL_AVDD_ 0V9	OTP_VCC_1 V8	PLL_AVDD_ 1V8	VSS	XIN_24M	XOUT_24M	Е
LOGIC_VDD	LOGIC_VDD	VSS	VSS	VSS	VSS	GPIO4_B0/ UART4_RX	GPIO4_B5/I 2S0_2CH_S CLK/MAC_M DC_M1	GPIO4_B3		F
LOGIC_VDD	LOGIC_VDD	VSS	VSS	PLL_VSS	GPIO4_B2	GPIO4_A3/ SDIO_D3/M AC_RXD1_ M1	GPIO4_A2/ SDIO_D2/M AC_RXD0_ M1			G
VSS	VSS	VSS	GPIO4_C0/I 2S0_2CH_S DI	GPIO4_B7/I 2S0_2CH_S DO/MAC_TX EN_M1	GPIO4_B4/I 2S0_2CH_M CLK/MAC_C LK_M1	VSS	GPIO4_A4/ SDIO_CMD/ MAC_TXDO_ M1			н
VSS	VSS	VSS	VCCIO4	GPIO4_B6/I 2S0_2CH_L RCK_TX/MA C_MDIO_M 1	GPIO4_B1/ UART4_TX	GPIO4_A1/ SDIO_D1/M AC_RXDV_ M1	GPIO4_A5/ SDIO_CLK/ MAC_TXD1_ M1	GPIO4_A0/ SDIO_D0/M AC_RXER_M 1		J
VSS	VSS	VSS	VSS	VSS	VSS	VSS	GPIO4_A7/ UART4_RTS N	GPIO4_A6/ UART4_CTS N		К

Fig.2-11 RK3308B-S Ball Map-3

VSS	VSS	VSS	VSS	VSS	VSS	CODEC_A VSS	CODEC _AVSS	CODEC_A VSS	CODEC_AVS S	
VSS	VSS	VSS	VSS	VSS	CODEC_AVS S	CODEC_A VDD_1V8	CODEC _MICN6	CODEC_M ICN8	CODEC_MIC P8	
VSS	VSS	VSS	VSS	VSS	CODEC_AVS S	CODEC_A VDD_1V8	CODEC _MICP6	CODEC_M ICN7	CODEC_MIC P7	1
VSS	VSS	VSS	VSS	VSS	CODEC_AVD D_3V3	CODEC_M ICN3	CODEC _MICP3	CODEC_M ICN5	CODEC_MIC P5	F
VCCI01	VCCI03		VSS	GPIO2_A5/I2S 0_8CH_SCLK_ TX/SPI1_MOSI _M1	GPIO2_B0/I 2S0_8CH_L RCK_RX/PW M7	CODEC_A VSS	CODEC _VCM	CODEC_M ICN4	CODEC_MIC P4	F
VCCIO2	GPIO3_B5/F LASH_CSN0 /I2C3_SCL_ M1/SPI1_CS N0/UART3_T	GPIO3_B1/F LASH_CLE/E MMC_CLK/L CDC_D21_M 1	GPIO2_B5/I2S 0_8CH_SDI0/P DM_8CH_SDI0 _M2	GPIO2_A4/I2S  0_8CH_MCLK/ PDM_8CH_CLK  _M_M2/SPI1_ MISO_M1	GPIO2_A6/I 2S0_8CH_S CLK_RX/PD M_8CH_CLK _S_M2	GPIO2_B4 /I2S0_8C H_SDO3/ PWM10	CODEC _VCMH	CODEC_A VSS	CODEC_VC M_LINEOUT	י
GPIO3_A0/F LASH_D0/E MMC_D0/SF C_SIO0	GPIO3_A7/F LASH_D7/E MMC_D7/LC DC_D19_M1	GPIO3_B2/F LASH_RDN/ SPI1_MISO/ LCDC_D22_ M1	GPIO2_A0/UA RT0_RX/SPI0_ MISO/I2C3_S DA_M2	GPIO2_B6/I2S 0_8CH_SDI1/P DM_8CH_SDI1 _M2	GPIO2_B3/I 2S0_8CH_S DO2/PWM9	VSS	CODEC _MICBI AS2	CODEC_M ICN2	CODEC_MIC P2	l
GPIO3_A5/F LASH_D5/E MMC_D5/SF C_CSN0	GPIO3_A1/F LASH_D1/E MMC_D1/SF C_SIO1	GPIO3_B0/F LASH_WRN/ EMMC_CMD/ LCDC_D20_ M1	GPIO2_B1/I2S 0_8CH_SDO0/ SPI1_CSN0_M 1/LCDC_D20	GPIO2_B2/I2S 0_8CH_SDO1/ PWM8/LCDC_ D21	GPIO2_A1/U ART0_TX/SP I0_MOSI/I2 C3_SCL_M2	GPIO2_A7 /I2S0_8C H_LRCK_T X/SPI1_C LK_M1	CODEC _HPDET	CODEC_M ICN1	CODEC_MIC P1	١
GPIO3_A4/F LASH_D4/E MMC_D4/SF C_CLK	GPIO3_B4/F LASH_RDY/I 2C3_SDA_M 1/SPI1_MOS I/UART3_RX		GPIO2_B7/I2S 0_8CH_SDI2/P DM_8CH_SDI2 _M2/LCDC_D2 2	•	GPIO2_A3/U ART0_RTSN/ SPI0_CSN0/ I2C2_SCL		CODEC _HPOU T_R	CODEC_LI NEOUT_R	CODEC_LIN EOUT_L	v
GPIO3_A3/F LASH_D3/E MMC_D3/SF C_HOLD_SI O3	GPIO3_A2/F LASH_D2/E MMC_D2/SF C_WP_SIO2		GPIO2_C0/I2S 0_8CH_SDI3/P DM_8CH_SDI3 _M2/LCDC_D2 3/PWM11		GPIO2_A2/U ART0_CTSN /SPI0_CLK/I 2C2_SDA/O WIRE_M2		CODEC _MICBI AS1	CODEC_H POUT_L	CODEC_AVS S	,
11	12	13	14	15	16	17	18	19	20	

Fig.2-12 RK3308B-S Ball Map-4

#### RK3308H-S

	1	2	3	4	5	6	7	8	9	10		
Α	VSS	VSS	VSS	VSS	VSS	VSS			VSS	VSS		
В	VSS	VSS	VSS	VSS	VSS	VSS	VSS	VSS	VSS	VSS		
С		VSS	VSS	VSS	DDR_VDD	VSS	VSS	VSS	VSS			
D		VSS	VSS		DDR_VDD	DDR_VDD	DDR_VDD	VSS		FP_3		
E	VSS	VSS	VSS	VSS	VSS	VSS	DDR_VDD	VSS	VSS	DDR_VDD		
F	VSS	VSS	VSS	VSS	FP_1	VREF	DDR_VDD	DDR_VDD	DDR_VDD	LOGIC_VDD		
G	VSS	VSS	VSS		DDR_VDD	DDR_VDD		VSS	VSS	LOGIC_VDD		
Н		DDR_VDD	DDR_VDD	DDR_VDD		DDR_VDD	VSS	VSS	VSS	VSS		
J			vss	VSS	VSS	DDR_VDD	VSS	VSS	VSS	VSS		
К	VSS	DDR_VDD	VSS	vss	VSS		VSS	VSS	VSS	VSS		
!	Fig.2-13 RK3308H-S Ball Map-1											
	5	5										

										_
L	DDR_V DD	VSS	VSS	VSS	VSS		VSS	VSS	VSS	VSS
М		VSS		VSS	VSS	VSS	VSS	VSS	VSS	VSS
N	VSS	GPIO0_ C5/OTG _DRVB US	GPIO 0_A0/ SDIO _INT N	GPIO0_A1 /SDIO_W RPT/PWM 4	VCCIO0	CORE_VDD	CORE_VDD	CORE_VDD	VSS	VSS
Р			GPIO 0_A2/ SDIO _PWR EN	GPIO0_A3 /SDMMC_ DET	CORE_VDD	CORE_VDD	CORE_VDD	VSS	VSS	VSS
R			GPIO 0_A4/ TEST _CLK OUT	GPIO0_A5	CORE_VDD	CORE_VDD	VSS	CORE_VDD	GPIO1_C4/LCDC _D16/I2S1_8CH_ SDO3_SDI1_M1/ PDM_8CH_SDI1_ M1/MAC_RXD0	GPIO3_B3/ FLASH_ALE /EMMC_PW REN/SPI1_ CLK/LCDC_ D23_M1
Т	GPIOO_ C1/SPD IF_TX/P WM5/U ART3_R X_M1	GPIO0_ C4	GPIO 0_B0	GPIO0_A7	GPIO0_A6	GPIO1_B2/LC DC_D6/I2S1_ 8CH_SDO3_S DI1_M0/PDM_ 8CH_SDI1_M 0	VSS	GPIO1_B5/LCDC _D9/I2S1_8CH_S CLK_TX_M1/MAC _MDC	GPIO1_C7/UART1 _RTSN/UART2_T X_M0/SPI2_MOSI /JTAG_TMS/LCDC _D19	GPIO1_D1/ UART1_TX/ I2C0_SCL/ SPI2_CSN0
U		GPIO0_ CO/PW M3/I2C 3_SCL_ M0	GPIO 0_B2/ TSAD C_SH UT	GPIO1_A2 /LCDC_VS YNC/I2S1 _8CH_MC LK_M0	GPIO1_A6/L CDC_D2/I2S 1_8CH_LRCK _RX_M0	GPIO1_B1/LC DC_D5/12S1_ 8CH_SDO2_S DI2_M0/PDM_ 8CH_SDI2_M 0	GPIO1_B3/LCDC _D7/I2S1_8CH_ SDI0_M0/PDM_ 8CH_SDI0_M0	GPIO1_C2/LCDC _D14/I2S1_8CH_ SDO1_SDI3_M1/ PDM_8CH_SDI3_ M1/MAC_TXD0	GPIO1_C3/LCDC _D15/I2S1_8CH_ SDO2_SDI2_M1/ PDM_8CH_SDI2_ M1/MAC_TXD1	GPIO3_A6/ FLASH_D6/ EMMC_D6/ LCDC_D18 _M1
V	GPIO0_ B4/I2C 1_SCL	GPIO0_ B3/I2C 1_SDA/ OWIRE _M0	GPIO 0_B5/ PWM0	GPIO1_A1 /LCDC_H SYNC	GPIO1_A5/L CDC_D1/I2S 1_8CH_LRCK _TX_M0	GPIO1_B0/LC DC_D4/I2S1_ 8CH_SDO1_S DI3_M0/PDM_ 8CH_SDI3_M 0	GPIO1_B4/LCDC _D8/I2S1_8CH_ MCLK_M1/MAC_ CLK	GPIO1_C1/LCDC _D13/I2S1_8CH_ SDO0_M1/MAC_T XEN	GPIO1_C0/LCDC _D12/I2S1_8CH_ LRCK_RX_M1/MA C_RXDV	GPIO1_D0/ UART1_RX/ I2C0_SDA/ SPI2_CLK
W	GPIO0_ B7/PW M2/I2C 3_SDA _M0	GPIO0_ B6/PW M1	GPIO 0_C2/ SPDIF _RX/P WM6/ UART 3_TX _M1	GPIO1_A3 /LCDC_DE N/I2S1_8 CH_SCLK _TX_M0	GPIO1_A4/L CDC_D0/I2S 1_8CH_SCLK _RX_M0/PDM _8CH_CLK_M 0	GPIO1_A7/LC DC_D3/12S1_ 8CH_SD00_M 0	GPIO1_B6/LCDC _D10/I2S1_8CH _SCLK_RX_M1/P DM_8CH_CLK_M 1/MAC_MDIO		GPIO1_C6/UART1 _CTSN/UART2_R X_M0/SPI2_MISO /JTAG_TCK/OWIR E_M1/LCDC_D18	
Y	VSS	GPIO0_ C3/RTC _CLK	GPIO 0_B1/ PMIC _SLEE P		GPIO1_A0/L CDC_DCLK		GPIO1_B7/LCDC _D11/I2S1_8CH _LRCK_TX_M1/ MAC_RXER		GPIO1_C5/LCDC _D17/I2S1_8CH_ SDI0_M1/PDM_8 CH_SDI0_M1/MA C_RXD1	
				7						

Fig.2-14 RK3308H-S Ball Map-2

11	12	13	14	15	16	17	18	19	20	
	USB1_DM	USB0_DM		GPIO4_D3/ SDMMC_D3 /UART2_TX _M1		GPIO4_D1/ SDMMC_D1	ADC_IN3	ADC_IN0	VSS	А
VSS	USB1_DP	USB0_DP	GPIO4_D6/ SDMMC_PW REN	GPIO4_D2/ SDMMC_D2 /UART2_RX _M1	GPIO4_D5/ SDMMC_CL K	GPIO4_D0/ SDMMC_D0	ADC_IN4	ADC_IN1	NPOR	В
VSS	USB_ID	VSS	USB_VBUS	NC	GPIO4_D4/ SDMMC_CM D	VSS	ADC_IN2	NPOR_BYPA SS	REF_CLKOU	С
VSS	VSS	USB_AVDD _3V3	VCCIO5	USB_VDD_0 V9	USB_AVDD _1V8	SADC_AVD D_1V8	ADC_IN5	TVSS	VSS	D
VSS	VSS	VSS	USB_AVDD _3V3	PLL_AVDD_ 0V9	OTP_VCC_1 V8	PLL_AVDD_ 1V8	VSS	XIN_24M	XOUT_24M	E
LOGIC_VDD	LOGIC_VDD	VSS	VSS	VSS	VSS	GPIO4_B0/ UART4_RX	GPIO4_B5/I 2S0_2CH_S CLK/MAC_M DC_M1	GPIO4_B3		F
LOGIC_VDD	LOGIC_VDD	VSS	VSS	PLL_VSS	GPIO4_B2	GPIO4_A3/ SDIO_D3/M AC_RXD1_ M1	GPIO4_A2/ SDIO_D2/M AC_RXD0_ M1			G
VSS	VSS	VSS	GPIO4_C0/I 2S0_2CH_S DI	GPIO4_B7/I 2S0_2CH_S DO/MAC_TX EN_M1	GPIO4_B4/I 2S0_2CH_M CLK/MAC_C LK_M1	VSS	GPIO4_A4/ SDIO_CMD/ MAC_TXDO_ M1			Н
VSS	VSS	VSS	VCCIO4	GPIO4_B6/I 2S0_2CH_L RCK_TX/MA C_MDIO_M	GPIO4_B1/ UART4_TX	GPIO4_A1/ SDIO_D1/M AC_RXDV_ M1	GPIO4_A5/ SDIO_CLK/ MAC_TXD1_ M1	GPIO4_A0/ SDIO_D0/M AC_RXER_M 1		J
VSS	VSS	VSS	VSS	VSS	VSS	VSS	GPIO4_A7/ UART4_RTS N	GPIO4_A6/ UART4_CTS N		К

Fig.2-15 RK3308H-S Ball Map-3

VSS	VSS	VSS	VSS	VSS	VSS	CODEC_A VSS	CODEC _AVSS	CODEC_A VSS	CODEC_AVS S	L
VSS	VSS	VSS	VSS	VSS	CODEC_AVS S	CODEC_A VDD_1V8	CODEC _MICN6	CODEC_M ICN8	CODEC_MIC P8	М
VSS	VSS	VSS	VSS	VSS	CODEC_AVS S	CODEC_A VDD_1V8	CODEC _MICP6	CODEC_M ICN7	CODEC_MIC P7	N
VSS	VSS	VSS	VSS	VSS	CODEC_AVD D_3V3	CODEC_M ICN3	CODEC _MICP3	CODEC_M ICN5	CODEC_MIC P5	Р
VCCIO1	VCCIO3		VSS	GPIO2_A5/I2S 0_8CH_SCLK_ TX/SPI1_MOSI _M1	GPIO2_B0/I 2S0_8CH_L RCK_RX/PW M7	CODEC_A VSS	CODEC _VCM	CODEC_M ICN4	CODEC_MIC P4	R
VCCIO2	GPIO3_B5/F LASH_CSN0 /I2C3_SCL_ M1/SPI1_CS N0/UART3_T X	GPIO3_B1/F LASH_CLE/E MMC_CLK/ LCDC_D21_ M1	GPIO2_B5/I2S 0_8CH_SDI0/P DM_8CH_SDI0 _M2	GPIO2_A4/I2S 0_8CH_MCLK/ PDM_8CH_CLK _M_M2/SPI1_ MISO_M1	GPIO2_A6/I 2S0_8CH_S CLK_RX/PD M_8CH_CLK _S_M2	GPIO2_B4 /I2S0_8C H_SDO3/ PWM10	CODEC _VCMH	CODEC_A VSS	CODEC_VC M_LINEOUT	Т
GPIO3_A0/F LASH_D0/E MMC_D0/SF C_SIO0	GPIO3_A7/F LASH_D7/E MMC_D7/LC DC_D19_M1	GPIO3_B2/F LASH_RDN/ SPI1_MISO/ LCDC_D22_ M1	GPIO2_A0/UA RT0_RX/SPI0_ MISO/I2C3_S DA_M2	GPIO2_B6/I2S 0_8CH_SDI1/P DM_8CH_SDI1 _M2	GPIO2_B3/I 2S0_8CH_S DO2/PWM9	VSS	CODEC _MICBI AS2	CODEC_M ICN2	CODEC_MIC P2	U
GPIO3_A5/F LASH_D5/E MMC_D5/SF C_CSN0	GPIO3_A1/F LASH_D1/E MMC_D1/SF C_SIO1	GPIO3_B0/F LASH_WRN/ EMMC_CMD/ LCDC_D20_ M1	GPIO2_B1/I2S 0_8CH_SD00/ SPI1_CSN0_M 1/LCDC_D20	GPIO2_B2/I2S 0_8CH_SD01/ PWM8/LCDC_D 21	GPIO2_A1/U ART0_TX/SP I0_MOSI/I2 C3_SCL_M2	GPIO2_A7 /I2S0_8C H_LRCK_T X/SPI1_C LK_M1	CODEC _HPDET	CODEC_M ICN1	CODEC_MIC P1	v
GPIO3_A4/F LASH_D4/E MMC_D4/SF C_CLK	GPIO3_B4/F LASH_RDY/I 2C3_SDA_M 1/SPI1_MOS I/UART3_RX		GPIO2_B7/I2S 0_8CH_SDI2/P DM_8CH_SDI2 _M2/LCDC_D2 2		GPIO2_A3/U ART0_RTSN/ SPI0_CSN0/ I2C2_SCL		CODEC _HPOU T_R	CODEC_LI NEOUT_R	CODEC_LIN EOUT_L	w
GPIO3_A3/F LASH_D3/E MMC_D3/SF C_HOLD_SI O3	GPIO3_A2/F LASH_D2/E MMC_D2/SF C_WP_SIO2		GPIO2_C0/I2S 0_8CH_SDI3/P DM_8CH_SDI3 _M2/LCDC_D2 3/PWM11		GPIO2_A2/U ART0_CTSN/ SPI0_CLK/I2 C2_SDA/OW IRE_M2		CODEC _MICBI AS1	CODEC_H POUT_L	CODEC_AVS S	Y
11	12	13	14	15	16	17	18	19	20	

Fig.2-16 RK3308H-S Ball Map-4

## 2.5 Pin Number List

• RK3308B-S

Table 2-1 RK3308B-S Pin Number List Information

No.	Pin Name	No.	Pin Name
A1	VSS	L3	DDR_DM1
A2	DDR_A7	L4	DDR_DQ10
А3	DDR_A2	L5	VSS
A4	VSS	L7	VSS
A5	DDR_A1	L8	VSS
A6	DDR_A6	L9	VSS
A9	VSS	L10	VSS
A10	DDR_A8	L11	VSS
A12	USB1_DM	L12	VSS
A13	USB0_DM	L13	VSS
A15	GPIO4_D3/SDMMC_D3/UART2_TX_M1	L14	VSS
A17	GPIO4_D1/SDMMC_D1	L15	VSS
A18	ADC_IN3	L16	VSS
A19	ADC_IN0	L17	CODEC_AVSS
A20	VSS	L18	CODEC_AVSS
В1	DDR_CS0N	L19	CODEC_AVSS
B2	DDR_BA0	L20	CODEC_AVSS
В3	DDR_A5	M2	DDR_DQ14
B4	DDR_A0	M4	VSS
B5	DDR_A11	M5	VSS
В6	DDR_A12	M6	VSS
В7	DDR_A4	M7	VSS
В8	VSS	M8	VSS
В9	DDR_CKE	M9	VSS
B10	DDR_A14	M10	VSS
B11	VSS	M11	VSS
B12	USB1_DP	M12	VSS
B13	USB0_DP	M13	VSS
B14	GPIO4_D6/SDMMC_PWREN	M14	VSS
B15	GPIO4_D2/SDMMC_D2/UART2_RX_M1	M15	VSS
B16	GPIO4_D5/SDMMC_CLK	M16	CODEC_AVSS
B17	GPIO4_D0/SDMMC_D0	M17	CODEC_AVDD_1V8
B18	ADC_IN4	M18	CODEC_MICN6
B19	ADC_IN1	M19	CODEC_MICN8
B20	NPOR	M20	CODEC_MICP8
C2	DDR_CLKN	N1	VSS
С3	DDR_CLK	N2	GPIO0_C5/OTG_DRVBUS
C4	VSS	N3	GPIOO_AO/SDIO_INTN
C5	DDR_ODT0	N4	GPIO0_A1/SDIO_WRPT/PWM4
C6	VSS	N5	VCCIO0

No.	Pin Name	No.	Pin Name
C7	VSS	N6	CORE_VDD
C8	DDR_BA1	N7	CORE_VDD
C9	DDR_A10	N8	CORE_VDD
C11	VSS	N9	VSS
C12	USB_ID	N10	VSS
C13	VSS	N11	VSS
C14	USB_VBUS	N12	VSS
C15	NC	N13	VSS
C16	GPIO4_D4/SDMMC_CMD	N14	VSS
C17	VSS	N15	VSS
C18	ADC_IN2	N16	CODEC_AVSS
C19	NPOR_BYPASS	N17	CODEC_AVDD_1V8
C20	REF_CLKOUT	N18	CODEC_MICP6
D2	VSS	N19	CODEC_MICN7
D3	DDR_DQ11	N20	CODEC_MICP7
D5	DDR_RASN	Р3	GPIO0_A2/SDIO_PWREN
D6	DDR_BA2	P4	GPIO0_A3/SDMMC_DET
D7	DDR_A13	P5	CORE_VDD
D8	DDR_CASN	P6	CORE_VDD
D10	FP_3	P7	CORE_VDD
D11	VSS	P8	VSS
D12	VSS	P9	VSS
D13	USB_AVDD_3V3	P10	VSS
D14	VCCIO5	P11	VSS
D15	USB_VDD_0V9	P12	VSS
D16	USB_AVDD_1V8	P13	VSS
D17	SADC_AVDD_1V8	P14	VSS
D18	ADC_IN5	P15	VSS
D19	TVSS	P16	CODEC_AVDD_3V3
D20	VSS	P17	CODEC_MICN3
E1	VSS	P18	CODEC_MICP3
E2	DDR_DQ4	P19	CODEC_MICN5
E3	DDR_DQ6	P20	CODEC_MICP5
E4	DDR_RESET	R3	GPIO0_A4/TEST_CLKOUT
E5	VSS	R4	GPIO0_A5
E6	DDR_A3	R5	CORE_VDD
E7	DDR_A9	R6	CORE_VDD
E8	DDR_WEN	R7	VSS
E9	VSS	R8	CORE_VDD
			GPIO1_C4/LCDC_D16/I2S1_8CH_SDO3_SDI1_M1/PDM_8CH_SD
E10	DDR_VDD	R9	I1_M1/MAC_RXD0
E11	VSS	R10	GPIO3_B3/FLASH_ALE/EMMC_PWREN/SPI1_CLK/LCDC_D23_M1
E12	VSS	R11	VCCIO1
E13	VSS	R12	VCCIO3

No.	Pin Name	No.	Pin Name
E14	USB_AVDD_3V3	R14	VSS
E15	PLL_AVDD_0V9	R15	GPIO2_A5/I2S0_8CH_SCLK_TX/SPI1_MOSI_M1
E16	OTP_VCC_1V8	R16	GPIO2_B0/I2S0_8CH_LRCK_RX/PWM7
E17	PLL_AVDD_1V8	R17	CODEC_AVSS
E18	VSS	R18	CODEC_VCM
E19	XIN_24M	R19	CODEC_MICN4
E20	XOUT_24M	R20	CODEC_MICP4
F1	DDR_DQ5	T1	GPIOO_C1/SPDIF_TX/PWM5/UART3_RX_M1
F2	VSS	T2	GPIOO_C4
F3	DDR_DQ13	T3	GPIOO_E4
F4	DDR_DQ8	T4	GPIOO_BO
-	<u> </u>		
F5	FP_1	T5	GPIO0_A6
F.C	ED 2	TC	GPIO1_B2/LCDC_D6/I2S1_8CH_SDO3_SDI1_M0/PDM_8CH_SDI
F6	FP_2	T6	1_M0
F7	DDR_VDD	T7	VSS
F8	DDR_VDD	T8	GPIO1_B5/LCDC_D9/I2S1_8CH_SCLK_TX_M1/MAC_MDC
			GPIO1_C7/UART1_RTSN/UART2_TX_M0/SPI2_MOSI/JTAG_TMS/
F9	DDR_VDD	Т9	LCDC_D19
F10	LOGIC_VDD	T10	GPIO1_D1/UART1_TX/I2C0_SCL/SPI2_CSN0
F11	LOGIC_VDD	T11	VCCIO2
F12	LOGIC_VDD	T12	GPIO3_B5/FLASH_CSN0/I2C3_SCL_M1/SPI1_CSN0/UART3_TX
F13	VSS	T13	GPIO3_B1/FLASH_CLE/EMMC_CLK/LCDC_D21_M1
F14	VSS	T14	GPIO2_B5/I2S0_8CH_SDI0/PDM_8CH_SDI0_M2
			GPIO2_A4/I2S0_8CH_MCLK/PDM_8CH_CLK_M_M2/SPI1_MISO_
F15	VSS	T15	M1
F16	VSS	T16	GPIO2_A6/I2S0_8CH_SCLK_RX/PDM_8CH_CLK_S_M2
F17	GPIO4_B0/UART4_RX	T17	GPIO2_B4/I2S0_8CH_SDO3/PWM10
	GPIO4_B5/I2S0_2CH_SCLK/MAC_MDC		
F18	_M1	T18	CODEC_VCMH
F19	GPIO4_B3	T19	CODEC_AVSS
G1	DDR_DM0	T20	CODEC_VCM_LINEOUT
G2	DDR_DQ9	U2	GPIO0_C0/PWM3/I2C3_SCL_M0
G3	VSS	U3	GPIO0_B2/TSADC_SHUT
G5	DDR_DQ1	U4	GPIO1_A2/LCDC_VSYNC/I2S1_8CH_MCLK_M0
G6	DDR_VDD	U5	GPIO1_A6/LCDC_D2/I2S1_8CH_LRCK_RX_M0
			GPIO1_B1/LCDC_D5/I2S1_8CH_SDO2_SDI2_M0/PDM_8CH_SDI
G8	VSS	U6	2_M0
G9	VSS	U7	GPIO1_B3/LCDC_D7/I2S1_8CH_SDI0_M0/PDM_8CH_SDI0_M0
			GPIO1_C2/LCDC_D14/I2S1_8CH_SDO1_SDI3_M1/PDM_8CH_SD
G10	LOGIC_VDD	U8	I3_M1/MAC_TXD0
			GPIO1_C3/LCDC_D15/I2S1_8CH_SDO2_SDI2_M1/PDM_8CH_SD
G11	LOGIC_VDD	U9	I2_M1/MAC_TXD1
G12	LOGIC_VDD	U10	GPIO3_A6/FLASH_D6/EMMC_D6/LCDC_D18_M1
G13	VSS	U11	GPIO3_A0/FLASH_D0/EMMC_D0/SFC_SIO0
G14	VSS	U12	GPIO3_A7/FLASH_D7/EMMC_D7/LCDC_D19_M1

No	Din Nama	N.	Din Name
No.	Pin Name	No.	Pin Name
G15	PLL_VSS	U13	GPIO3_B2/FLASH_RDN/SPI1_MISO/LCDC_D22_M1
G16	GPIO4_B2	U14	GPIO2_A0/UART0_RX/SPI0_MISO/I2C3_SDA_M2
G17	GPIO4_A3/SDIO_D3/MAC_RXD1_M1	U15	GPIO2_B6/I2S0_8CH_SDI1/PDM_8CH_SDI1_M2
G18	GPIO4_A2/SDIO_D2/MAC_RXD0_M1	U16	GPIO2_B3/I2S0_8CH_SDO2/PWM9
H2	DDR_DQS1	U17	VSS
Н3	DDR_DQS1N	U18	CODEC_MICBIAS2
H4	DDR_DQ2	U19	CODEC_MICN2
Н6	DDR_VDD	U20	CODEC_MICP2
H7	VSS	V1	GPIO0_B4/I2C1_SCL
Н8	VSS	V2	GPIO0_B3/I2C1_SDA/OWIRE_M0
Н9	VSS	V3	GPIO0_B5/PWM0
H10	VSS	V4	GPIO1_A1/LCDC_HSYNC
H11	VSS	V5	GPIO1_A5/LCDC_D1/I2S1_8CH_LRCK_TX_M0
			GPIO1_B0/LCDC_D4/I2S1_8CH_SD01_SDI3_M0/PDM_8CH_SDI
H12	VSS	V6	3_M0
H13	VSS	V7	GPIO1_B4/LCDC_D8/I2S1_8CH_MCLK_M1/MAC_CLK
H14	GPIO4_C0/I2S0_2CH_SDI	V8	GPIO1_C1/LCDC_D13/I2S1_8CH_SDO0_M1/MAC_TXEN
	GPIO4_B7/I2S0_2CH_SDO/MAC_TXEN		
H15	_M1	V9	GPIO1_C0/LCDC_D12/I2S1_8CH_LRCK_RX_M1/MAC_RXDV
	GPIO4_B4/I2S0_2CH_MCLK/MAC_CLK		
H16	_	V10	GPIO1_D0/UART1_RX/I2C0_SDA/SPI2_CLK
H17	VSS	V11	GPIO3_A5/FLASH_D5/EMMC_D5/SFC_CSN0
H18	GPIO4_A4/SDIO_CMD/MAC_TXD0_M1	V12	GPIO3 A1/FLASH D1/EMMC D1/SFC SIO1
13	DDR_DQS0	V13	GPIO3 B0/FLASH WRN/EMMC CMD/LCDC D20 M1
]4	DDR_DQ0	V14	GPIO2_B1/I2S0_8CH_SD00/SPI1_CSN0_M1/LCDC_D20
J5	VSS	V15	GPIO2_B2/I2S0_8CH_SD01/PWM8/LCDC_D21
J6	DDR VDD	V16	GPIO2 A1/UARTO TX/SPIO MOSI/I2C3 SCL M2
J7	VSS	V17	GPIO2_A7/I2S0_8CH_LRCK_TX/SPI1_CLK_M1
J8	VSS	V18	CODEC_HPDET
J9	VSS	V19	CODEC MICN1
J10	VSS	V20	CODEC MICP1
J11	VSS	W1	GPIOO_B7/PWM2/I2C3_SDA_M0
J12	VSS	W2	GPIO0 B6/PWM1
J13	VSS	WZ W3	GPIO0_B0/FWH1  GPIO0 C2/SPDIF RX/PWM6/UART3 TX M1
J13	VCCIO4	W4	
J14		VV4	GPIO1_A3/LCDC_DEN/I2S1_8CH_SCLK_TX_M0
74.5	GPIO4_B6/I2S0_2CH_LRCK_TX/MAC_	\A/E	GPIO1_A4/LCDC_D0/I2S1_8CH_SCLK_RX_M0/PDM_8CH_CLK_M
J15	MDIO_M1	W5	0
J16	GPIO4_B1/UART4_TX	W6	GPIO1_A7/LCDC_D3/I2S1_8CH_SD00_M0
147			GPIO1_B6/LCDC_D10/I2S1_8CH_SCLK_RX_M1/PDM_8CH_CLK_
J17	GPIO4_A1/SDIO_D1/MAC_RXDV_M1	W7	M1/MAC_MDIO
		14.5	GPIO1_C6/UART1_CTSN/UART2_RX_M0/SPI2_MISO/JTAG_TCK/
J18	GPIO4_A5/SDIO_CLK/MAC_TXD1_M1	W9	OWIRE_M1/LCDC_D18
J19	GPIO4_A0/SDIO_D0/MAC_RXER_M1	W11	GPIO3_A4/FLASH_D4/EMMC_D4/SFC_CLK
K1	VSS	W12	GPIO3_B4/FLASH_RDY/I2C3_SDA_M1/SPI1_MOSI/UART3_RX
K2	DDR_DQ7	W14	GPIO2_B7/I2S0_8CH_SDI2/PDM_8CH_SDI2_M2/LCDC_D22

No.	Pin Name	No.	Pin Name
К3	VSS	W16	GPIO2_A3/UART0_RTSN/SPI0_CSN0/I2C2_SCL
K4	DDR_DQS0N	W18	CODEC_HPOUT_R
K5	DDR_DQ15	W19	CODEC_LINEOUT_R
K7	VSS	W20	CODEC_LINEOUT_L
K8	VSS	Y1	VSS
К9	VSS	Y2	GPIO0_C3/RTC_CLK
K10	VSS	Y3	GPIO0_B1/PMIC_SLEEP
K11	VSS	Y5	GPIO1_A0/LCDC_DCLK
K12	VSS	Y7	GPIO1_B7/LCDC_D11/I2S1_8CH_LRCK_TX_M1/MAC_RXER
			GPIO1_C5/LCDC_D17/I2S1_8CH_SDI0_M1/PDM_8CH_SDI0_M1
K13	VSS	Y9	/MAC_RXD1
K14	VSS	Y11	GPIO3_A3/FLASH_D3/EMMC_D3/SFC_HOLD_SIO3
K15	VSS	Y12	GPIO3_A2/FLASH_D2/EMMC_D2/SFC_WP_SIO2
			GPIO2_C0/I2S0_8CH_SDI3/PDM_8CH_SDI3_M2/LCDC_D23/PW
K16	VSS	Y14	M11
K17	VSS	Y16	GPIO2_A2/UART0_CTSN/SPI0_CLK/I2C2_SDA/OWIRE_M2
K18	GPIO4_A7/UART4_RTSN	Y18	CODEC_MICBIAS1
K19	GPIO4_A6/UART4_CTSN	Y19	CODEC_HPOUT_L
L1	DDR_DQ3	Y20	CODEC_AVSS
L2	DDR_DQ12		

RK3308H-S Different Pin Number List Information with RK3308B-S

No.	RK3308B-S Pin Name	RK3308H-S Pin Name
A2	DDR_A7	VSS
A3	DDR_A2	VSS
A5	DDR_A1	VSS
A6	DDR_A6	VSS
A10	DDR_A8	VSS
B1	DDR_CS0N	VSS
B2	DDR_BA0	VSS
В3	DDR_A5	VSS
B4	DDR_A0	VSS
B5	DDR_A11	VSS
B6	DDR_A12	VSS
B7	DDR_A4	VSS
В9	DDR_CKE	VSS
B10	DDR_A14	VSS
C2	DDR_CLKN	VSS
C3	DDR_CLK	VSS
C5	DDR_ODT0	DDR_VDD
C8	DDR_BA1	VSS
C9	DDR_A10	VSS
D3	DDR_DQ11	VSS
D5	DDR_RASN	DDR_VDD

No.	RK3308B-S Pin Name	RK3308H-S Pin Name
D6	DDR_BA2	DDR_VDD
D7	DDR_A13	DDR_VDD
D8	DDR_CASN	VSS
E2	DDR_DQ4	VSS
E3	DDR_DQ6	VSS
E4	DDR_RESET	VSS
E6	DDR_A3	VSS
E7	DDR_A9	DDR_VDD
E8	DDR_WEN	VSS
F1	DDR_DQ5	VSS
F3	DDR_DQ13	VSS
F4	DDR_DQ8	VSS
F6	FP_2	VREF
G1	DDR_DM0	VSS
G2	DDR_DQ9	VSS
G5	DDR_DQ1	DDR_VDD
H2	DDR_DQS1	DDR_VDD
H3	DDR_DQS1N	DDR_VDD
H4	DDR_DQ2	DDR_VDD
J3	DDR_DQS0	VSS
J4	DDR_DQ0	VSS
K2	DDR_DQ7	DDR_VDD
K4	DDR_DQS0N	VSS
K5	DDR_DQ15	VSS
L1	DDR_DQ3	DDR_VDD
L2	DDR_DQ12	VSS
L3	DDR_DM1	VSS
L4	DDR_DQ10	VSS
M2	DDR_DQ14	VSS

# 2.6 Power/Ground IO Description

• RK3308B-S

Table 2-2 RK3308B-S Power/Ground IO information

Group	Ball#	Descriptions
	A1,A4,A9,A20,	
	B8,B11,	
	C4,C6,C7,C11,C13,C17,	
VSS	D2,D11,D12,D20,	Digital Cround
V33	E1,E5,E9,E11,E12,E13,E18,	Digital Ground
	F2,F13,F14,F15,F16,	
	G3,G8,G9,G13,G14,	
	H7,H8,H9,H10,H11,H12,H13,H17,	

Group	Ball#	Descriptions
	J5,J7,J8,J9,J10,J11,J12,J13,	
	K1,K3,K7,K8,K9,K10,K11,K12,K13,K14,K15,K16,K17,	
	L5,L7,L8,L9,L10,L11,L12,L13,L14,L15,L16,	
	M4,M5,M6,M7,M8,M9,M10,M11,M12,M13,M14,M15,	
	N1,N9,N10,N11,N12,N13,N14,N15,	
	P8,P9,P10,P11,P12,P13,P14,P15,	
	7 0,1 3,1 10,1 11,1 12,1 13,1 14,1 13, R7,R14,	
	T7,U17,Y1	
CODEC_AVSS	L17,L18,L19,L20,	Audio Codec Analog Ground
<del>-</del>	M16,N16,R17,T19,Y20	
PLL_VSS	G15	PLL Ground
	N6,N7,N8,	
CORE_VDD	P5,P6,P7,	ARM Core Power
	R5,R6,R8	
	F10,F11,F12,	
LOGIC_VDD	G10,G11,G12	Logic Power
VCCIO0	N5	VCCIO0 Power Domain Power
VCCIO1	R11	VCCIO1 Power Domain Power
VCCIO2	T11	VCCIO2 Power Domain Power
VCCIO3	R12	VCCIO3 Power Domain Power
VCCIO4	J14	VCCIO4 Power Domain Power
VCCIO5	D14	VCCIO5 Power Domain Power
700103		Veeles Fower Bernam Fower
	E10,	
		DDD DHY Dower
DDR_VDD	F7,F8,F9,	DDR PHY Power
	G6,H6,J6	
DI AVED 01/0	-15	84.8
PLL_AVDD_0V9	E15	PLL Power
PLL_AVDD_1V8	E17	PLL Power
		T
USB_VDD_0V9	D15	USB OTG2.0/Host2.0 PHY Power
USB_AVDD_1V8	D16	USB OTG2.0/Host2.0 PHY Power
USB_AVDD_3V3	D13,	USB OTG2.0/Host2.0 PHY Power
030_AVDD_3V3	E14	OSB OTGZ.0/1103tZ.0 1111 Tower
	M17,	
CODEC_AVDD_1V8	N17	Audio Codec Analog Power
CODEC_AVDD_3V3	P16	Audio Codec Analog Power
		<u>,                                      </u>
SADC_AVDD_1V8	D17	SARADC Analog Power
	- <del> ·</del>	
OTP_VCC_1V8	E16	OTP Analog Power
011-100-110	LIU	OTF Alialog Fowel

### • RK3308H-S

Table 2-3 RK3308H-S Power/Ground IO information

Group	Ball#	Descriptions
	A1,A2,A3,A4,A5,A6,A9,A10,A20,	
VSS	B1,B2,B3,B4,B5,B6,B7,B8,B9,B10,B11,	
	C2,C3,C4,C6,C7,C8,C9,C11,C13,C17,	
	D2,D3,D8,D11,D12,D20,	
	E1,E2,E3,E4,E5,E6,E8,E9,E11,E12,E13,E18,	
	F1,F2,F3,F4,F13,F14,F15,F16,	
	G1,G2,G3,G8,G9,G13,G14,	Digital Ground
	H7,H8,H9,H10,H11,H12,H13,H17,	
	J3,J4,J5,J7,J8,J9,J10,J11,J12,J13,	* * * * * * * * * * * * * * * * * * * *
	K1,K3,K4,K5,K7,K8,K9,K10,K11,K12,K13,K14,K15,K16,K17,	
	L2,L3,L4,L5,L7,L8,L9,L10,L11,L12,L13,L14,L15,L16,	
	M2,M4,M5,M6,M7,M8,M9,M10,M11,M12,M13,M14,M15,	
	N1,N9,N10,N11,N12,N13,N14,N15,	
	P8,P9,P10,P11,P12,P13,P14,P15,	
	R7,R14,T7,U17,Y1	
CODEC_AVSS	L17,L18,L19,L20,	Audio Codec Analog Ground
	M16,N16,R17,T19,Y20	
PLL_VSS	G15	PLL Ground
CORE_VDD	N6,N7,N8,	ARM Core Power
	P5,P6,P7,	
	R5,R6,R8	
LOGIC_VDD	F10,F11,F12,	
	G10,G11,G12	Logic Power
VCCIO0	N5	VCCIO0 Power Domain Power
VCCIO1	R11	VCCIO1 Power Domain Power
VCCIO2	T11	VCCIO2 Power Domain Power
VCCIO3	R12	VCCIO3 Power Domain Power
VCCIO4	J14	VCCIO4 Power Domain Power
VCCIO5	D14	VCCIO5 Power Domain Power
DDR_VDD	C5,D5,D6,D7	DDR PHY Power
	E7,E10,F7,F8,F9,	
	G5,G6,	
	H2,H3,H4,H6,	
	J6,K2,L1	
PLL_AVDD_0V9	E15	PLL Power
PLL_AVDD_1V8	E17	PLL Power

Group	Ball#	Descriptions
LICE VDD OVO	D15	USB OTG2.0/Host2.0 PHY
USB_VDD_0V9	D15	Power
LICE AVED 1V0	D16	USB OTG2.0/Host2.0 PHY
USB_AVDD_1V8	D16	Power
LICE AVED 3V3	D13,	USB OTG2.0/Host2.0 PHY
USB_AVDD_3V3	E14	Power
CODEC AVDD 1V0	M17,	Audio Codos Analos Bayyar
CODEC_AVDD_1V8	N17	Audio Codec Analog Power
CODEC_AVDD_3V3	P16	Audio Codec Analog Power
SADC_AVDD_1V8	D17	SARADC Analog Power
OTP_VCC_1V8	E16	OTP Analog Power

# **2.7 Function IO Description**

• RK3308B-S

Table 2-4 RK3308B-S Function IO description

						SUOD-S FUIIC			<u> </u>	Pad	Def		Drive		DIE Power
Pin	Pin Name	Func1	Func2	Func3	Func4	Func5	Func6	Func7	Func8	Type①	3	Pull	Strength@	INT	Domain
E19	XIN_24M	XIN_24M								I	I	N/A	N/A		DI 1 1 1 1 D 1 1 1 1 1 1 1 1 1 1 1 1 1 1
E20	XOUT_24M	XOUT_24M								0	0	N/A	N/A		PLL_AVDD_0V9
B20	NPOR	NPOR						10		I	I	up	N/A		
D19	TVSS	TVSS								I	I	down	N/A		DI AVDD 1V0
C19	NPOR_BYPASS	NPOR_BYPASS								I/O	I	down	2mA		PLL_AVDD_1V8
C20	REF_CLKOUT	REF_CLKOUT								I/O	I	down	2mA		
N3	GPIO0_A0/SDIO_INTN	GPIO0_A0	SDIO_INTN							I/O	I	down	2mA	√	
N4	GPIO0_A1/SDIO_WRPT/P WM4	GPIO0_A1	SDIO_WRPT	PWM4						I/O	I	down	2mA	√	
Р3	GPIO0_A2/SDIO_PWREN	GPIO0_A2	SDIO_PWRE				7			I/O	I	down	2mA	√	
P4	GPIO0_A3/SDMMC_DET	GPIO0_A3	SDMMC_DET							I/O	I	up	2mA	√	
R3	GPIO0_A4/TEST_CLKOUT	GPIO0_A4	TEST_CLKO UT		()					I/O	I	up	2mA	√	
R4	GPIO0_A5	GPIO0_A5			NY					I/O	I	down	2mA	√	
T5	GPIO0_A6	GPIO0_A6								I/O	I	down	2mA	√	VCCIO0
T4	GPIO0_A7	GPIO0_A7								I/O	I	down	2mA	√	
Т3	GPIO0_B0	GPIO0_B0		110						I/O	I	down	2mA	√	
Y3	GPIO0_B1/PMIC_SLEEP	GPIO0_B1	PMIC_SLEEP							I/O	I	down	2mA	√	
U3	GPIO0_B2/TSADC_SHUT	GPIO0_B2	TSADC_SHU T							I/O	I	high-	2mA	√	
V2	GPIO0_B3/I2C1_SDA/OWI RE_M0	GPIO0_B3	I2C1_SDA	OWIRE_M0						I/O	I	up	2mA	√	
V1	GPIO0_B4/I2C1_SCL	GPIO0_B4	I2C1_SCL							I/O	I	up	2mA	√	1
V3	GPIO0_B5/PWM0	GPIO0_B5	PWM0							I/O	I	down	2mA	√	1

Pin	Pin Name	Func1	Func2	Func3	Func4	Func5	Func6	Func7	Func8	Pad Type①	Def 3	Pull	Drive Strength②	INT	DIE Power Domain
W2	GPIO0_B6/PWM1	GPIO0_B6	PWM1							I/O	I	down	2mA	√	
W1	GPIO0_B7/PWM2/I2C3_S DA_M0	GPIO0_B7	PWM2	I2C3_SDA_M0					×	I/O	I	down	2mA	√	
U2	GPIO0_C0/PWM3/I2C3_S CL_M0	GPIO0_C0	PWM3	I2C3_SCL_M0						I/O	I	down	2mA	√	
T1	GPIO0_C1/SPDIF_TX/PW M5/UART3_RX_M1	GPIO0_C1	SPDIF_TX	PWM5	UART3_R X_M1					I/O	I	down	2mA	<b>√</b>	
W3	GPIO0_C2/SPDIF_RX/PW M6/UART3_TX_M1	GPIO0_C2	SPDIF_RX	PWM6	UART3_T X_M1		C	Ó	,	I/O	I	down	2mA	√	
Y2	GPIO0_C3/RTC_CLK	GPIO0_C3	RTC_CLK							I/O	I	high-	2mA	<b>~</b>	
T2	GPIO0_C4	GPIO0_C4								I/O	I	down	2mA	√	
N2	GPIO0_C5/OTG_DRVBUS	GPIO0_C5	OTG_DRVBU S				) `			I/O	I	down	2mA	√	
Y5	GPIO1_A0/LCDC_DCLK	GPIO1_A0	LCDC_DCLK							I/O	I	down	2mA	√	
V4	GPIO1_A1/LCDC_HSYNC	GPIO1_A1	LCDC_HSYN C		5					I/O	I	down	2mA	<b>√</b>	
U4	GPIO1_A2/LCDC_VSYNC/I 2S1_8CH_MCLK_M0	GPIO1_A2	LCDC_VSYN C	I2S1_8CH_MCLK_ M0						I/O	I	down	2mA	<b>√</b>	
W4	GPIO1_A3/LCDC_DEN/I2S 1_8CH_SCLK_TX_M0	GPIO1_A3	LCDC_DEN	I2S1_8CH_SCLK_ TX_M0						I/O	I	down	2mA	√	VCCIO1
W5	GPIO1_A4/LCDC_D0/I2S1 _8CH_SCLK_RX_M0/PDM_ 8CH_CLK_M0	GPIO1_A4	LCDC_D0	I2S1_8CH_SCLK_ RX_M0	PDM_8CH _CLK_M0					I/O	I	down	2mA	<b>~</b>	VCCIOI
V5	GPIO1_A5/LCDC_D1/I2S1 _8CH_LRCK_TX_M0	GPIO1_A5	LCDC_D1	I2S1_8CH_LRCK_ TX_M0						I/O	I	down	2mA	√	
U5	GPIO1_A6/LCDC_D2/I2S1 _8CH_LRCK_RX_M0	GPIO1_A6	LCDC_D2	I2S1_8CH_LRCK_ RX_M0						I/O	I	down	2mA	√	

Pin	Pin Name	Func1	Func2	Func3	Func4	Func5	Func6	Func7	Func8	Pad Type①	Def 3	Pull	Drive Strength②	INT	DIE Power Domain
W6	GPIO1_A7/LCDC_D3/I2S1 _8CH_SDO0_M0	GPIO1_A7	LCDC_D3	I2S1_8CH_SDO0_ M0					•	I/O	Ī	down	2mA	<b>√</b>	
V6	GPIO1_B0/LCDC_D4/I2S1 _8CH_SD01_SDI3_M0/PD M_8CH_SDI3_M0	GPIO1_B0	LCDC_D4	I2S1_8CH_SDO1_ SDI3_M0	PDM_8CH _SDI3_M0				)X	I/O	I	down	2mA	<b>~</b>	
U6	GPIO1_B1/LCDC_D5/I2S1 _8CH_SDO2_SDI2_M0/PD M_8CH_SDI2_M0	GPIO1_B1	LCDC_D5	I2S1_8CH_SDO2_ SDI2_M0	PDM_8CH _SDI2_M0			X		I/O	I	down	2mA	<b>√</b>	
Т6	GPIO1_B2/LCDC_D6/I2S1 _8CH_SDO3_SDI1_M0/PD M_8CH_SDI1_M0	GPIO1_B2	LCDC_D6	I2S1_8CH_SDO3_ SDI1_M0	PDM_8CH _SDI1_M0			5		I/O	I	down	2mA	<b>\</b>	
U7	GPIO1_B3/LCDC_D7/I2S1 _8CH_SDI0_M0/PDM_8CH _SDI0_M0	GPIO1_B3	LCDC_D7	I2S1_8CH_SDI0_ M0	PDM_8CH _SDI0_M0		) '			I/O	I	down	2mA	<b>~</b>	
V7	GPIO1_B4/LCDC_D8/I2S1 _8CH_MCLK_M1/MAC_CL K	GPIO1_B4	LCDC_D8	I2S1_8CH_MCLK_ M1	MAC_CLK	)				I/O	I	down	2mA	√	
Т8	GPIO1_B5/LCDC_D9/I2S1 _8CH_SCLK_TX_M1/MAC_ MDC	GPIO1_B5	LCDC_D9	I2S1_8CH_SCLK_ TX_M1	MAC_MDC					I/O	I	down	2mA	√	
W7	GPIO1_B6/LCDC_D10/I2S  1_8CH_SCLK_RX_M1/PDM  _8CH_CLK_M1/MAC_MDI  O	GPIO1_B6	LCDC_D10	I2S1_8CH_SCLK_ RX_M1	PDM_8CH _CLK_M1	MAC_MDIO				I/O	I	down	2mA	<b>~</b>	
Y7	GPIO1_B7/LCDC_D11/I2S 1_8CH_LRCK_TX_M1/MAC _RXER	GPIO1_B7	LCDC_D11	I2S1_8CH_LRCK_ TX_M1	MAC_RXE					I/O	I	down	2mA	√	

Pin	Pin Name	Func1	Func2	Func3	Func4	Func5	Func6	Func7	Func8	Pad	Def	Pull	Drive	INT	DIE Power
										Type①	3		Strength2		Domain
V9	GPIO1_C0/LCDC_D12/I2S  1_8CH_LRCK_RX_M1/MAC  RXDV	GPIO1_C0	LCDC_D12	I2S1_8CH_LRCK_ RX_M1	MAC_RXD V					I/O	I	down	2mA	√	
V8	GPIO1_C1/LCDC_D13/I2S 1_8CH_SDO0_M1/MAC_T XEN	GPIO1_C1	LCDC_D13	I2S1_8CH_SDO0_ M1	MAC_TXE			. (		I/O	I	down	2mA	√	
U8	GPIO1_C2/LCDC_D14/I2S  1_8CH_SDO1_SDI3_M1/P  DM_8CH_SDI3_M1/MAC_  TXD0	GPIO1_C2	LCDC_D14	I2S1_8CH_SD01_ SDI3_M1	PDM_8CH _SDI3_M1	MAC_TXD0	Ċ			I/O	I	down	2mA	√	
U9	GPIO1_C3/LCDC_D15/I2S 1_8CH_SDO2_SDI2_M1/P DM_8CH_SDI2_M1/MAC_ TXD1	GPIO1_C3	LCDC_D15	I2S1_8CH_SDO2_ SDI2_M1	PDM_8CH _SDI2_M1	MAC_TXD1				I/O	I	down	2mA	√	
R9	GPIO1_C4/LCDC_D16/I2S  1_8CH_SD03_SDI1_M1/P  DM_8CH_SDI1_M1/MAC_  RXD0	GPIO1_C4	LCDC_D16	I2S1_8CH_SDO3_ SDI1_M1	PDM_8CH _SDI1_M1	MAC_RXD0				I/O	I	down	2mA	√	
Y9	GPIO1_C5/LCDC_D17/I2S 1_8CH_SDI0_M1/PDM_8C H_SDI0_M1/MAC_RXD1	GPIO1_C5	LCDC_D17	I2S1_8CH_SDI0_ M1	PDM_8CH _SDI0_M1	MAC_RXD1				I/O	I	down	2mA	√	
W9	GPIO1_C6/UART1_CTSN/ UART2_RX_M0/SPI2_MIS O/JTAG_TCK/OWIRE_M1/ LCDC_D18	GPIO1_C6	UART1_CTS N	UART2_RX_M0	SPI2_MIS	JTAG_TCK	OWIRE_ M1	LCDC_D1		I/O	I	up	2mA	√	
Т9	GPIO1_C7/UART1_RTSN/ UART2_TX_M0/SPI2_MOS I/JTAG_TMS/LCDC_D19	GPIO1_C7	UART1_RTS	UART2_TX_M0	SPI2_MOS	JTAG_TMS	LCDC_D1			I/O	I	up	2mA	√	

Pin	Pin Name	Func1	Func2	Func3	Func4	Func5	Func6	Func7	Func8	Pad	Def	Pull	Drive	INT	DIE Power
										Type①	3		Strength@		Domain
V10	GPIO1_D0/UART1_RX/I2C 0_SDA/SPI2_CLK	GPIO1_D0	UART1_RX	I2C0_SDA	SPI2_CLK				•	I/O	I	ир	2mA	√	
T10	GPIO1_D1/UART1_TX/I2C 0_SCL/SPI2_CSN0	GPIO1_D1	UART1_TX	I2C0_SCL	SPI2_CSN				X	I/O	I	up	2mA	√	
U14	GPIO2_A0/UART0_RX/SPI 0_MISO/I2C3_SDA_M2	GPIO2_A0	UARTO_RX	SPIO_MISO	I2C3_SDA _M2					I/O	I	up	2mA	√	
V16	GPIO2_A1/UART0_TX/SPI 0_MOSI/I2C3_SCL_M2	GPIO2_A1	UARTO_TX	SPI0_MOSI	I2C3_SCL _M2					I/O	I	up	2mA	√	
Y16	GPIO2_A2/UART0_CTSN/ SPI0_CLK/I2C2_SDA/OWI RE_M2	GPIO2_A2	UARTO_CTS N	SPIO_CLK	I2C2_SDA	OWIRE_M2				I/O	I	up	2mA	<b>√</b>	
W16	GPIO2_A3/UART0_RTSN/S PI0_CSN0/I2C2_SCL	GPIO2_A3	UARTO_RTS N	SPI0_CSN0	I2C2_SCL	<u> </u>				I/O	I	up	2mA	√	
T15	GPIO2_A4/I2S0_8CH_MCL K/PDM_8CH_CLK_M_M2/S PI1_MISO_M1	GPIO2_A4	I2S0_8CH_M CLK	PDM_8CH_CLK_M _M2	SPI1_MIS O_M1	0				I/O	I	down	2mA	√	Vicetoo
R15	GPIO2_A5/I2S0_8CH_SCL K_TX/SPI1_MOSI_M1	GPIO2_A5	I2S0_8CH_S CLK_TX	SPI1_MOSI_M1						I/O	I	down	2mA	√	VCCIO2
T16	GPIO2_A6/I2S0_8CH_SCL K_RX/PDM_8CH_CLK_S_M 2	GPIO2_A6	I2S0_8CH_S CLK_RX	PDM_8CH_CLK_S _M2						I/O	I	down	2mA	√	
V17	GPIO2_A7/I2S0_8CH_LRC K_TX/SPI1_CLK_M1	GPIO2_A7	I2S0_8CH_L RCK_TX	SPI1_CLK_M1						I/O	I	down	2mA	√	
R16	GPIO2_B0/I2S0_8CH_LRC K_RX/PWM7	GPIO2_B0	I2S0_8CH_L RCK_RX	PWM7						I/O	I	down	2mA	√	
V14	GPIO2_B1/I2S0_8CH_SD O0/SPI1_CSN0_M1/LCDC _D20	GPIO2_B1	I2S0_8CH_S D00	SPI1_CSN0_M1	LCDC_D2					I/O	I	down	2mA	√	

Pin	Pin Name	Func1	Func2	Func3	Func4	Func5	Func6	Func7	Func8	Pad Type①	Def 3	Pull	Drive Strength②	INT	DIE Power Domain
V15	GPIO2_B2/I2S0_8CH_SD O1/PWM8/LCDC_D21	GPIO2_B2	I2S0_8CH_S D01	PWM8	LCDC_D2 1				•	I/O	I	down	2mA	√	
U16	GPIO2_B3/I2S0_8CH_SD O2/PWM9	GPIO2_B3	I2S0_8CH_S D02	PWM9					X	I/O	I	down	2mA	√	
T17	GPIO2_B4/I2S0_8CH_SD O3/PWM10	GPIO2_B4	I2S0_8CH_S D03	PWM10						I/O	I	down	2mA	√	
T14	GPIO2_B5/I2S0_8CH_SDI 0/PDM_8CH_SDI0_M2	GPIO2_B5	I2SO_8CH_S DI0	PDM_8CH_SDI0_ M2						I/O	I	down	2mA	√	
U15	GPIO2_B6/I2S0_8CH_SDI 1/PDM_8CH_SDI1_M2	GPIO2_B6	I2S0_8CH_S DI1	PDM_8CH_SDI1_ M2			8			I/O	I	down	2mA	√	
W14	GPIO2_B7/I2S0_8CH_SDI 2/PDM_8CH_SDI2_M2/LC DC_D22	GPIO2_B7	I2S0_8CH_S DI2	PDM_8CH_SDI2_ M2	LCDC_D2					I/O	I	down	2mA	√	
Y14	GPIO2_C0/I2S0_8CH_SDI 3/PDM_8CH_SDI3_M2/LC DC_D23/PWM11	GPIO2_C0	I2S0_8CH_S DI3	PDM_8CH_SDI3_ M2	LCDC_D2	PWM11				I/O	I	down	2mA	<b>√</b>	
U11	GPIO3_A0/FLASH_D0/EM MC_D0/SFC_SIO0	GPIO3_A0	FLASH_D0	EMMC_D0	SFC_SIO0					I/O	I	up	8mA	√	
V12	GPIO3_A1/FLASH_D1/EM MC_D1/SFC_SIO1	GPIO3_A1	FLASH_D1	EMMC_D1	SFC_SIO1					I/O	I	up	8mA	√	
Y12	GPIO3_A2/FLASH_D2/EM MC_D2/SFC_WP_SIO2	GPIO3_A2	FLASH_D2	EMMC_D2	SFC_WP_ SIO2					I/O	I	up	8mA	√	VCCIO3
Y11	GPIO3_A3/FLASH_D3/EM MC_D3/SFC_HOLD_SIO3	GPIO3_A3	FLASH_D3	EMMC_D3	SFC_HOL D_SIO3					I/O	I	up	8mA	√	VCCIOS
W11	GPIO3_A4/FLASH_D4/EM MC_D4/SFC_CLK	GPIO3_A4	FLASH_D4	EMMC_D4	SFC_CLK					I/O	I	up	8mA	√	
V11	GPIO3_A5/FLASH_D5/EM MC_D5/SFC_CSN0	GPIO3_A5	FLASH_D5	EMMC_D5	SFC_CSN 0					I/O	I	up	8mA	√	

Pin	Pin Name	Func1	Func2	Func3	Func4	Func5	Func6	Func7	Func8	Pad Type①	Def 3	Pull	Drive Strength②	INT	DIE Power Domain
U10	GPIO3_A6/FLASH_D6/EM MC_D6/LCDC_D18_M1	GPIO3_A6	FLASH_D6	EMMC_D6	LCDC_D1 8_M1				•	I/O	I	up	8mA	√	<u> </u>
U12	GPIO3_A7/FLASH_D7/EM MC_D7/LCDC_D19_M1	GPIO3_A7	FLASH_D7	EMMC_D7	LCDC_D1 9_M1				X	I/O	I	up	8mA	√	
V13	GPIO3_B0/FLASH_WRN/E MMC_CMD/LCDC_D20_M1	GPIO3_B0	FLASH_WRN	EMMC_CMD	LCDC_D2 0_M1			. (		I/O	I	up	8mA	√	
T13	GPIO3_B1/FLASH_CLE/EM MC_CLK/LCDC_D21_M1	GPIO3_B1	FLASH_CLE	EMMC_CLK	LCDC_D2 1_M1				5	I/O	I	down	8mA	√	
U13	GPIO3_B2/FLASH_RDN/SP I1_MISO/LCDC_D22_M1	GPIO3_B2	FLASH_RDN	SPI1_MISO	LCDC_D2 2_M1					I/O	I	up	8mA	√	
R10	GPIO3_B3/FLASH_ALE/EM MC_PWREN/SPI1_CLK/LC DC_D23_M1	GPIO3_B3	FLASH_ALE	EMMC_PWREN	SPI1_CLK	LCDC_D23 _M1				I/O	I	down	8mA	√	
W12	GPIO3_B4/FLASH_RDY/I2 C3_SDA_M1/SPI1_MOSI/ UART3_RX	GPIO3_B4	FLASH_RDY	I2C3_SDA_M1	SPI1_MOS	UART3_RX				I/O	I	up	8mA	√	
T12	GPIO3_B5/FLASH_CSN0/I 2C3_SCL_M1/SPI1_CSN0/ UART3_TX	GPIO3_B5	FLASH_CSN 0	I2C3_SCL_M1	SPI1_CSN 0	UART3_TX				I/O	I	up	8mA	√	
J19	GPIO4_A0/SDIO_D0/MAC _RXER_M1	GPIO4_A0	SDIO_D0	MAC_RXER_M1						I/O	I	up	2mA	√	
J17	GPIO4_A1/SDIO_D1/MAC _RXDV_M1	GPIO4_A1	SDIO_D1	MAC_RXDV_M1						I/O	I	up	2mA	√	
G18	GPIO4_A2/SDIO_D2/MAC _RXD0_M1	GPIO4_A2	SDIO_D2	MAC_RXD0_M1						I/O	I	up	2mA	<b>√</b>	VCCIO4
G17	GPIO4_A3/SDIO_D3/MAC _RXD1_M1	GPIO4_A3	SDIO_D3	MAC_RXD1_M1						I/O	I	up	2mA	√	
H18	GPIO4_A4/SDIO_CMD/MA C_TXD0_M1	GPIO4_A4	SDIO_CMD	MAC_TXD0_M1						I/O	I	up	2mA	√	

Pin	Pin Name	Func1	Func2	Func3	Func4	Func5	Func6	Func7	Func8	Pad Type①	Def 3	Pull	Drive Strength②	INT	DIE Power Domain
J18	GPIO4_A5/SDIO_CLK/MA C_TXD1_M1	GPIO4_A5	SDIO_CLK	MAC_TXD1_M1					•	I/O	I	down	2mA	√	
K19	GPIO4_A6/UART4_CTSN	GPIO4_A6	UART4_CTS N						X	I/O	I	up	2mA	√	
K18	GPIO4_A7/UART4_RTSN	GPIO4_A7	UART4_RTS N					. (		I/O	I	up	2mA	√	
F17	GPIO4_B0/UART4_RX	GPIO4_B0	UART4_RX							I/O	I	up	2mA	√	
J16	GPIO4_B1/UART4_TX	GPIO4_B1	UART4_TX							I/O	I	up	2mA	√	
G16	GPIO4_B2	GPIO4_B2								I/O	I	down	2mA	√	
F19	GPIO4_B3	GPIO4_B3								I/O	I	down	2mA	√	
H16	GPIO4_B4/I2S0_2CH_MCL K/MAC_CLK_M1	GPIO4_B4	I2S0_2CH_M CLK	MAC_CLK_M1						I/O	I	down	2mA	√	
F18	GPIO4_B5/I2S0_2CH_SCL K/MAC_MDC_M1	GPIO4_B5	I2S0_2CH_S CLK	MAC_MDC_M1						I/O	I	down	2mA	√	
J15	GPIO4_B6/I2S0_2CH_LRC K_TX/MAC_MDIO_M1	GPIO4_B6	I2S0_2CH_L RCK_TX	MAC_MDIO_M1						I/O	I	down	2mA	√	
H15	GPIO4_B7/I2S0_2CH_SD O/MAC_TXEN_M1	GPIO4_B7	I2S0_2CH_S DO	MAC_TXEN_M1						I/O	I	down	2mA	√	
H14	GPIO4_C0/I2S0_2CH_SDI	GPIO4_C0	I2S0_2CH_S DI	X						I/O	I	down	2mA	√	
B17	GPIO4_D0/SDMMC_D0	GPIO4_D0	SDMMC_D0	PMU_ST0						I/O	I	up	8mA	√	
A17	GPIO4_D1/SDMMC_D1	GPIO4_D1	SDMMC_D1	PMU_ST1						I/O	I	up	8mA	√	
B15	GPIO4_D2/SDMMC_D2/UA RT2_RX_M1	GPIO4_D2	SDMMC_D2	UART2_RX_M1	PMU_ST2					I/O	I	up	8mA	√	VCCIOF
A15	GPIO4_D3/SDMMC_D3/UA RT2_TX_M1	GPIO4_D3	SDMMC_D3	UART2_TX_M1	PMU_ST3					I/O	I	up	8mA	√	VCCIO5
C16	GPIO4_D4/SDMMC_CMD	GPIO4_D4	SDMMC_CM D	PMU_ST4						I/O	I	up	8mA	√	

Pin	Pin Name	Func1	Func2	Func3	Func4	Func5	Func6	Func7	Func8	Pad	Def	Pull	Drive	INT	DIE Power
	· · · · · · · · · · · · · · · · · · ·			i unes		i unico	Tunco	i diliez	1 4.1100	Type①	3		Strength@		Domain
B16	GPIO4_D5/SDMMC_CLK	GPIO4_D5	SDMMC_CLK	PMU_DEBUGTX						I/O	I	down	8mA	√	
B14	GPIO4_D6/SDMMC_PWRE	GPIO4_D6	SDMMC_PW REN						×	I/O	I	down	8mA	√	
E2	DDR_DQ4	DDR_DQ4													
E3	DDR_DQ6	DDR_DQ6								·					
K2	DDR_DQ7	DDR_DQ7													
F1	DDR_DQ5	DDR_DQ5													
K4	DDR_DQS0N	DDR_DQS0N													
J3	DDR_DQS0	DDR_DQS0													
G5	DDR_DQ1	DDR_DQ1													
L1	DDR_DQ3	DDR_DQ3													
H4	DDR_DQ2	DDR_DQ2													
J4	DDR_DQ0	DDR_DQ0													
G1	DDR_DM0	DDR_DM0													
L3	DDR_DM1	DDR_DM1													
F4	DDR_DQ8	DDR_DQ8													DDR_VDD
L4	DDR_DQ10	DDR_DQ10													
D3	DDR_DQ11	DDR_DQ11													
G2	DDR_DQ9	DDR_DQ9													
H2	DDR_DQS1	DDR_DQS1													
Н3	DDR_DQS1N	DDR_DQS1N													
F3	DDR_DQ13	DDR_DQ13													
K5	DDR_DQ15	DDR_DQ15													
M2	DDR_DQ14	DDR_DQ14													
L2	DDR_DQ12	DDR_DQ12													
B10	DDR_A14	DDR_A14													
D7	DDR_A13	DDR_A13													
E4	DDR_RESET	DDR_RESET													

Pin	Pin Name	Func1	Func2	Func3	Func4	Func5	Func6	Func7	Func8	Pad	Def	Pull	Drive	INT	DIE Power
										Type <sub>①</sub>	3		Strength2		Domain
A10	DDR_A8	DDR_A8													
A2	DDR_A7	DDR_A7													
A6	DDR_A6	DDR_A6							X						
E7	DDR_A9	DDR_A9													
B5	DDR_A11	DDR_A11													
А3	DDR_A2	DDR_A2													
В7	DDR_A4	DDR_A4													
В3	DDR_A5	DDR_A5													
A5	DDR_A1	DDR_A1													
E6	DDR_A3	DDR_A3													
В6	DDR_A12	DDR_A12													
B4	DDR_A0	DDR_A0													
C8	DDR_BA1	DDR_BA1													
D6	DDR_BA2	DDR_BA2													
B2	DDR_BA0	DDR_BA0													
B1	DDR_CS0N	DDR_CS0N													
E8	DDR_WEN	DDR_WEN													
C9	DDR_A10	DDR_A10													
C5	DDR_ODT0	DDR_ODT0													
В9	DDR_CKE	DDR_CKE													
D8	DDR_CASN	DDR_CASN													
C2	DDR_CLKN	DDR_CLKN													
C3	DDR_CLK	DDR_CLK													
D5	DDR_RASN	DDR_RASN													
A19	ADC_IN0	ADC_IN0													
C18	ADC_IN2	ADC_IN2													CARARG
B19	ADC_IN1	ADC_IN1													SARADC
A18	ADC_IN3	ADC_IN3													

Pin	Pin Name	Func1	Func2	Func3	Func4	Func5	Func6	Func7	Func8	Pad	Def	Pull	Drive	INT	DIE Power
	riii itailie	runci	T uncz	runcs	i unc-	runcs	Tunco	i unc	Tunco	Type①	3	Full	Strength@	1141	Domain
B18	ADC_IN4	ADC_IN4													
D18	ADC_IN5	ADC_IN5													
B13	USB0_DP	USB0_DP							X						
A13	USB0_DM	USB0_DM													
C12	USB_ID	USB_ID													USB
C14	USB_VBUS	USB_VBUS													USB
B12	USB1_DP	USB1_DP													
A12	USB1_DM	USB1_DM													
W18	CODEC_HPOUT_R	CODEC_HPOUT								А					
W19	CODEC_LINEOUT_R	CODEC_LINEO UT_R								А					
V18	CODEC_HPDET	CODEC_HPDET								Α					
W20	CODEC_LINEOUT_L	CODEC_LINEO UT_L				5				А					
Y19	CODEC_HPOUT_L	CODEC_HPOUT								А					
T18	CODEC_VCMH	CODEC_VCMH								Α					Adia Cadaa
U18	CODEC_MICBIAS2	CODEC_MICBI AS2		X						А					Audio Codec
Y18	CODEC_MICBIAS1	CODEC_MICBI AS1								А					
V19	CODEC_MICN1	CODEC_MICN1								Α					
V20	CODEC_MICP1	CODEC_MICP1								Α					
U20	CODEC_MICP2	CODEC_MICP2								А					
U19	CODEC_MICN2	CODEC_MICN2								А					
R18	CODEC_VCM	CODEC_VCM								Α					
P18	CODEC_MICP3	CODEC_MICP3								А					

Pin	Pin Name	Func1	Func2	Func3	Func4	Func5	Func6	Func7	Func8	Pad	Def	Pull	Drive	INT	DIE Power
										Type①	3		Strength@		Domain
P17	CODEC_MICN3	CODEC_MICN3								Α					
R20	CODEC_MICP4	CODEC_MICP4								Α					
R19	CODEC_MICN4	CODEC_MICN4							X	Α					
P20	CODEC_MICP5	CODEC_MICP5								A					
P19	CODEC_MICN5	CODEC_MICN5								Α					
N18	CODEC_MICP6	CODEC_MICP6								Α					
M18	CODEC_MICN6	CODEC_MICN6								Α					
N20	CODEC_MICP7	CODEC_MICP7								Α					
N19	CODEC_MICN7	CODEC_MICN7								Α					
M20	CODEC_MICP8	CODEC_MICP8								Α					
M19	CODEC_MICN8	CODEC_MICN8								Α					
T20	CODEC VCM LINEOUT	CODEC_VCM_L													
T20	CODEC_VCM_LINEOUT	INEOUT								А					

#### Notes:

© Pad types: I = input, O = output, I/O = input/output (bidirectional)

AP = Analog Power, AG = Analog Ground

DP = Digital Power, DG = Digital Ground

A = Analog

②: Output Drive Unit is mA, only Digital IO has drive value;

③: Reset state: I = input, O = output;

#### • RK3308H-S

Table 2-5 RK3308H-S Function IO description

Pin	Pin Name	Func1	Func2	Func3	Func4	Func5	Func6	Func7	Func8	Pad Type①	Def 3	Pull	Drive Strength②	INT	DIE Power Domain
E19	XIN_24M	XIN_24M								I	I	N/A	N/A		DLL AVDD 0V0
E20	XOUT_24M	XOUT_24M								0	0	N/A	N/A		PLL_AVDD_0V9

Pin	Pin Name	Func1	Func2	Func3	Func4	Func5	Func6	Func7	Func8	Pad Type①	Def 3	Pull	Drive Strength②	INT	DIE Power Domain
B20	NPOR	NPOR								I	1	up	N/A		Domain
D19	TVSS	TVSS							•	1	ī	down	N/A		
C19	NPOR BYPASS	NPOR_BYPASS								I/O	I	down	2mA		PLL_AVDD_1V8
C20	REF_CLKOUT	REF_CLKOUT								I/O	I	down	2mA		
N3	GPIO0_A0/SDIO_INTN	GPIO0_A0	SDIO_INTN							I/O	I	down	2mA	√	
N4	GPIO0_A1/SDIO_WRPT/P WM4	GPIO0_A1	SDIO_WRPT	PWM4				7(		I/O	I	down	2mA	√	
Р3	GPIO0_A2/SDIO_PWREN	GPIO0_A2	SDIO_PWRE				C			I/O	I	down	2mA	√	
P4	GPIO0_A3/SDMMC_DET	GPIO0_A3	SDMMC_DET							I/O	I	up	2mA	√	
R3	GPIO0_A4/TEST_CLKOUT	GPIO0_A4	TEST_CLKO UT					•		I/O	I	up	2mA	√	
R4	GPIO0_A5	GPIO0_A5								I/O	I	down	2mA	√	
T5	GPIO0_A6	GPIO0_A6								I/O	I	down	2mA	√	
T4	GPIO0_A7	GPIO0_A7								I/O	I	down	2mA	√	
Т3	GPIO0_B0	GPIO0_B0								I/O	I	down	2mA	√	VCCIO0
Y3	GPIO0_B1/PMIC_SLEEP	GPIO0_B1	PMIC_SLEEP							I/O	I	down	2mA	√	VCCIOO
U3	GPIO0_B2/TSADC_SHUT	GPIO0_B2	TSADC_SHU T							I/O	I	high- z	2mA	√	
V2	GPIO0_B3/I2C1_SDA/OWI RE_M0	GPIO0_B3	I2C1_SDA	OWIRE_M0						I/O	I	up	2mA	√	
V1	GPIO0_B4/I2C1_SCL	GPIO0_B4	I2C1_SCL							I/O	I	up	2mA	√	
V3	GPIO0_B5/PWM0	GPIO0_B5	PWM0							I/O	I	down	2mA	√	
W2	GPIO0_B6/PWM1	GPIO0_B6	PWM1							I/O	I	down	2mA	√	
W1	GPIO0_B7/PWM2/I2C3_S DA_M0	GPIO0_B7	PWM2	I2C3_SDA_M0						I/O	I	down	2mA	√	
U2	GPIO0_C0/PWM3/I2C3_S CL_M0	GPIO0_C0	PWM3	I2C3_SCL_M0						I/O	I	down	2mA	√	

Pin	Pin Name	Func1	Func2	Func3	Func4	Func5	Func6	Func7	Func8	Pad	Def	Pull	Drive	INT	DIE Power
	T III Huile	runcz	runcz	runcs	Tunes	runes	Tunco			Type①	3	. u	Strength2	-1(1	Domain
T1	GPIO0_C1/SPDIF_TX/PW M5/UART3_RX_M1	GPIO0_C1	SPDIF_TX	PWM5	UART3_R X_M1				·	I/O	I	down	2mA	√	
W3	GPIO0_C2/SPDIF_RX/PW M6/UART3_TX_M1	GPIO0_C2	SPDIF_RX	PWM6	UART3_T X_M1					I/O	I	down	2mA	√	
Y2	GPIO0_C3/RTC_CLK	GPIO0_C3	RTC_CLK					7		I/O	I	high- z	2mA	√	
T2	GPIO0_C4	GPIO0_C4								I/O	I	down	2mA	√	
N2	GPIO0_C5/OTG_DRVBUS	GPIO0_C5	OTG_DRVBU S							I/O	I	down	2mA	√	
Y5	GPIO1_A0/LCDC_DCLK	GPIO1_A0	LCDC_DCLK							I/O	I	down	2mA	√	
V4	GPIO1_A1/LCDC_HSYNC	GPIO1_A1	LCDC_HSYN C							I/O	I	down	2mA	<b>√</b>	
U4	GPIO1_A2/LCDC_VSYNC/I 2S1_8CH_MCLK_M0	GPIO1_A2	LCDC_VSYN C	I2S1_8CH_MCLK_ M0						I/O	I	down	2mA	√	
W4	GPIO1_A3/LCDC_DEN/I2S 1_8CH_SCLK_TX_M0	GPIO1_A3	LCDC_DEN	I2S1_8CH_SCLK_ TX_M0						I/O	I	down	2mA	√	
W5	GPIO1_A4/LCDC_D0/I2S1 _8CH_SCLK_RX_M0/PDM_ 8CH_CLK_M0	GPIO1_A4	LCDC_D0	I2S1_8CH_SCLK_ RX_M0	PDM_8CH _CLK_M0					I/O	I	down	2mA	√	VCCIO1
V5	GPIO1_A5/LCDC_D1/I2S1 _8CH_LRCK_TX_M0	GPIO1_A5	LCDC_D1	I2S1_8CH_LRCK_ TX_M0						I/O	I	down	2mA	<b>√</b>	
U5	GPIO1_A6/LCDC_D2/I2S1 _8CH_LRCK_RX_M0	GPIO1_A6	LCDC_D2	I2S1_8CH_LRCK_ RX_M0						I/O	I	down	2mA	<b>√</b>	
W6	GPIO1_A7/LCDC_D3/I2S1 _8CH_SDO0_M0	GPIO1_A7	LCDC_D3	I2S1_8CH_SDO0_ M0						I/O	I	down	2mA	√	
V6	GPIO1_B0/LCDC_D4/I2S1 _8CH_SDO1_SDI3_M0/PD M_8CH_SDI3_M0	GPIO1_B0	LCDC_D4	I2S1_8CH_SDO1_ SDI3_M0	PDM_8CH _SDI3_M0					I/O	I	down	2mA	<b>√</b>	

Pin	Pin Name	Func1	Func2	Func3	Func4	Func5	Func6	Func7	Func8	Pad	Def	Pull	Drive	INT	DIE Power
		1 41102		- unes	1 4		Tunico			Type①	3		Strength@		Domain
	GPIO1_B1/LCDC_D5/I2S1			I2S1_8CH_SDO2_	PDM_8CH										
U6	_8CH_SDO2_SDI2_M0/PD	GPIO1_B1	LCDC_D5	SDI2_M0	_SDI2_M0					I/O	I	down	2mA	$\checkmark$	
	M_8CH_SDI2_M0			05120					X						
	GPIO1_B2/LCDC_D6/I2S1			I2S1 8CH SDO3	PDM 8CH										
Т6	_8CH_SDO3_SDI1_M0/PD	GPIO1_B2	LCDC_D6	SDI1_M0	_SDI1_M0					I/O	I	down	2mA	$\checkmark$	
	M_8CH_SDI1_M0			3511_110	_5511_110										
	GPIO1_B3/LCDC_D7/I2S1			I2S1_8CH_SDI0_	PDM_8CH										
U7	_8CH_SDI0_M0/PDM_8CH	GPIO1_B3	LCDC_D7	M0	_SDI0_M0					I/O	I	down	2mA	$\checkmark$	
	_SDI0_M0			140	_3D10_110										
	GPIO1_B4/LCDC_D8/I2S1			I2S1_8CH_MCLK_											
V7	_8CH_MCLK_M1/MAC_CL	GPIO1_B4	LCDC_D8	M1	MAC_CLK					I/O	I	down	2mA	$\checkmark$	
	K			MI											
	GPIO1_B5/LCDC_D9/I2S1			I2S1 8CH SCLK											
T8	_8CH_SCLK_TX_M1/MAC_	GPIO1_B5	LCDC_D9	TX_M1	MAC_MDC					I/O	I	down	2mA	$\checkmark$	
	MDC			IV_MI											
	GPIO1_B6/LCDC_D10/I2S														
W7	1_8CH_SCLK_RX_M1/PDM	GPIO1_B6	LCDC_D10	I2S1_8CH_SCLK_	PDM_8CH	MAC_MDIO				I/O	I	down	2mA	V	
VV /	_8CH_CLK_M1/MAC_MDI	GPIOI_B0	LCDC_D10	RX_M1	_CLK_M1	MAC_MDIO				1/0	1	down	ZIIIA	V	
	0														
	GPIO1_B7/LCDC_D11/I2S			I2S1_8CH_LRCK_	MAC_RXE										
Y7	1_8CH_LRCK_TX_M1/MAC	GPIO1_B7	LCDC_D11	TX_M1						I/O	I	down	2mA	$\checkmark$	
	_RXER			IX_MI	R										
	GPIO1_C0/LCDC_D12/I2S			IDC1 OCH LDCV	MAC DVD										
V9	1_8CH_LRCK_RX_M1/MAC	GPIO1_C0	LCDC_D12	I2S1_8CH_LRCK_	MAC_RXD V					I/O	I	down	2mA	$\checkmark$	
	_RXDV			RX_M1	V										
	GPIO1_C1/LCDC_D13/I2S			1361 0611 6062	MAC TVE										
V8	1_8CH_SD00_M1/MAC_T	GPIO1_C1	LCDC_D13	I2S1_8CH_SD00_	MAC_TXE					I/O	I	down	2mA	$\checkmark$	
	XEN			M1	N										

Pin	Pin Name	Func1	Func2	Func3	Func4	Func5	Func6	Func7	Func8	Pad Type①	Def 3	Pull	Drive Strength②	INT	DIE Power Domain
U8	GPIO1_C2/LCDC_D14/I2S 1_8CH_SDO1_SDI3_M1/P DM_8CH_SDI3_M1/MAC_ TXD0	GPIO1_C2	LCDC_D14	I2S1_8CH_SDO1_ SDI3_M1	PDM_8CH _SDI3_M1	MAC_TXD0			×	I/O	I	down	2mA	√	
U9	GPIO1_C3/LCDC_D15/I2S  1_8CH_SDO2_SDI2_M1/P  DM_8CH_SDI2_M1/MAC_  TXD1	GPIO1_C3	LCDC_D15	I2S1_8CH_SDO2_ SDI2_M1	PDM_8CH _SDI2_M1	MAC_TXD1		X		I/O	I	down	2mA	√	
R9	GPIO1_C4/LCDC_D16/I2S  1_8CH_SDO3_SDI1_M1/P  DM_8CH_SDI1_M1/MAC_  RXD0	GPIO1_C4	LCDC_D16	I2S1_8CH_SDO3_ SDI1_M1	PDM_8CH _SDI1_M1	MAC_RXD0				I/O	I	down	2mA	√	
Y9	GPIO1_C5/LCDC_D17/I2S 1_8CH_SDI0_M1/PDM_8C H_SDI0_M1/MAC_RXD1	GPIO1_C5	LCDC_D17	I2S1_8CH_SDI0_ M1	PDM_8CH _SDI0_M1	MAC_RXD1	)			I/O	I	down	2mA	√	
W9	GPIO1_C6/UART1_CTSN/ UART2_RX_M0/SPI2_MIS O/JTAG_TCK/OWIRE_M1/ LCDC_D18	GPIO1_C6	UART1_CTS	UART2_RX_M0	SPI2_MIS O	JTAG_TCK	OWIRE_ M1	LCDC_D1		I/O	I	up	2mA	√	
Т9	GPIO1_C7/UART1_RTSN/ UART2_TX_M0/SPI2_MOS I/JTAG_TMS/LCDC_D19	GPIO1_C7	UART1_RTS	UART2_TX_M0	SPI2_MOS	JTAG_TMS	LCDC_D1			I/O	I	up	2mA	√	
V10	GPIO1_D0/UART1_RX/I2C 0_SDA/SPI2_CLK	GPIO1_D0	UART1_RX	I2C0_SDA	SPI2_CLK					I/O	I	up	2mA	√	
T10	GPIO1_D1/UART1_TX/I2C 0_SCL/SPI2_CSN0	GPIO1_D1	UART1_TX	I2C0_SCL	SPI2_CSN 0					I/O	I	up	2mA	<b>√</b>	
U14	GPIO2_A0/UART0_RX/SPI 0_MISO/I2C3_SDA_M2	GPIO2_A0	UARTO_RX	SPI0_MISO	I2C3_SDA _M2					I/O	I	up	2mA	√	VCCIO2

Pin	Pin Name	Func1	Func2	Func3	Func4	Func5	Func6	Func7	Func8	Pad Type①	Def 3	Pull	Drive Strength②	INT	DIE Power Domain
V16	GPIO2_A1/UART0_TX/SPI 0_MOSI/I2C3_SCL_M2	GPIO2_A1	UARTO_TX	SPI0_MOSI	I2C3_SCL _M2				•	I/O	I	up	2mA	√	
Y16	GPIO2_A2/UART0_CTSN/ SPI0_CLK/I2C2_SDA/OWI RE_M2	GPIO2_A2	UARTO_CTS	SPIO_CLK	I2C2_SDA	OWIRE_M2			Š	I/O	I	up	2mA	<b>√</b>	
W16	GPIO2_A3/UART0_RTSN/S PI0_CSN0/I2C2_SCL	GPIO2_A3	UARTO_RTS N	SPI0_CSN0	I2C2_SCL			76		I/O	I	up	2mA	√	
T15	GPIO2_A4/I2S0_8CH_MCL K/PDM_8CH_CLK_M_M2/S PI1_MISO_M1	GPIO2_A4	I2S0_8CH_M CLK	PDM_8CH_CLK_M _M2	SPI1_MIS O_M1			0		I/O	I	down	2mA	√	
R15	GPIO2_A5/I2S0_8CH_SCL K_TX/SPI1_MOSI_M1	GPIO2_A5	I2S0_8CH_S CLK_TX	SPI1_MOSI_M1						I/O	I	down	2mA	√	
T16	GPIO2_A6/I2S0_8CH_SCL K_RX/PDM_8CH_CLK_S_M 2	GPIO2_A6	I2S0_8CH_S CLK_RX	PDM_8CH_CLK_S _M2						I/O	I	down	2mA	√	
V17	GPIO2_A7/I2S0_8CH_LRC K_TX/SPI1_CLK_M1	GPIO2_A7	I2S0_8CH_L RCK_TX	SPI1_CLK_M1						I/O	I	down	2mA	√	
R16	GPIO2_B0/I2S0_8CH_LRC K_RX/PWM7	GPIO2_B0	I2S0_8CH_L RCK_RX	PWM7						I/O	I	down	2mA	√	
V14	GPIO2_B1/I2S0_8CH_SD O0/SPI1_CSN0_M1/LCDC _D20	GPIO2_B1	I2S0_8CH_S D00	SPI1_CSN0_M1	LCDC_D2					I/O	I	down	2mA	<b>√</b>	
V15	GPIO2_B2/I2S0_8CH_SD O1/PWM8/LCDC_D21	GPIO2_B2	I2S0_8CH_S D01	PWM8	LCDC_D2					I/O	I	down	2mA	√	
U16	GPIO2_B3/I2S0_8CH_SD O2/PWM9	GPIO2_B3	I2S0_8CH_S DO2	PWM9						I/O	I	down	2mA	√	
T17	GPIO2_B4/I2S0_8CH_SD O3/PWM10	GPIO2_B4	I2S0_8CH_S D03	PWM10						I/O	I	down	2mA	√	

Pin	Pin Name	Func1	Func2	Func3	Func4	Func5	Func6	Func7	Func8	Pad Type①	Def 3	Pull	Drive Strength②	INT	DIE Power Domain
T14	GPIO2_B5/I2S0_8CH_SDI 0/PDM_8CH_SDI0_M2	GPIO2_B5	I2S0_8CH_S DI0	PDM_8CH_SDI0_ M2					•	I/O	Ĭ	down	2mA	√	
U15	GPIO2_B6/I2S0_8CH_SDI 1/PDM_8CH_SDI1_M2	GPIO2_B6	I2S0_8CH_S DI1	PDM_8CH_SDI1_ M2					X	I/O	I	down	2mA	√	
W14	GPIO2_B7/I2S0_8CH_SDI 2/PDM_8CH_SDI2_M2/LC DC_D22	GPIO2_B7	I2S0_8CH_S DI2	PDM_8CH_SDI2_ M2	LCDC_D2 2			76		I/O	I	down	2mA	<b>√</b>	
Y14	GPIO2_C0/I2S0_8CH_SDI 3/PDM_8CH_SDI3_M2/LC DC_D23/PWM11	GPIO2_C0	I2S0_8CH_S DI3	PDM_8CH_SDI3_ M2	LCDC_D2	PWM11	Ċ	0		I/O	I	down	2mA	<b>√</b>	
U11	GPIO3_A0/FLASH_D0/EM MC_D0/SFC_SIO0	GPIO3_A0	FLASH_D0	EMMC_D0	SFC_SIO0					I/O	I	up	8mA	√	
V12	GPIO3_A1/FLASH_D1/EM MC_D1/SFC_SIO1	GPIO3_A1	FLASH_D1	EMMC_D1	SFC_SIO1					I/O	I	up	8mA	√	
Y12	GPIO3_A2/FLASH_D2/EM MC_D2/SFC_WP_SIO2	GPIO3_A2	FLASH_D2	EMMC_D2	SFC_WP_ SIO2					I/O	I	up	8mA	√	
Y11	GPIO3_A3/FLASH_D3/EM MC_D3/SFC_HOLD_SIO3	GPIO3_A3	FLASH_D3	EMMC_D3	SFC_HOL D_SIO3					I/O	I	up	8mA	√	
W11	GPIO3_A4/FLASH_D4/EM MC_D4/SFC_CLK	GPIO3_A4	FLASH_D4	EMMC_D4	SFC_CLK					I/O	I	up	8mA	√	VCCIO3
V11	GPIO3_A5/FLASH_D5/EM MC_D5/SFC_CSN0	GPIO3_A5	FLASH_D5	EMMC_D5	SFC_CSN 0					I/O	I	up	8mA	√	
U10	GPIO3_A6/FLASH_D6/EM MC_D6/LCDC_D18_M1	GPIO3_A6	FLASH_D6	EMMC_D6	LCDC_D1 8_M1					I/O	I	up	8mA	√	
U12	GPIO3_A7/FLASH_D7/EM MC_D7/LCDC_D19_M1	GPIO3_A7	FLASH_D7	EMMC_D7	LCDC_D1 9_M1					I/O	I	up	8mA	√	
V13	GPIO3_B0/FLASH_WRN/E MMC_CMD/LCDC_D20_M1	GPIO3_B0	FLASH_WRN	EMMC_CMD	LCDC_D2 0_M1					I/O	I	up	8mA	√	

Pin	Pin Name	Func1	Func2	Func3	Func4	Func5	Func6	Func7	Func8	Pad	Def	Pull	Drive	INT	DIE Power
	GPIO3_B1/FLASH_CLE/EM				LCDC_D2					Type①	3		Strength2		Domain
T13	MC_CLK/LCDC_D21_M1	GPIO3_B1	FLASH_CLE	EMMC_CLK	1_M1					I/O	I	down	8mA	√	
U13	GPIO3_B2/FLASH_RDN/SP	GPIO3_B2	FLASH_RDN	SPI1_MISO	LCDC_D2				X	I/O	I	up	8mA	<b>√</b>	
	I1_MISO LCDC_D22_M1	_		_	2_M1					<u>O</u>		·			
D10	GPIO3_B3/FLASH_ALE/EM	CDIO2 D2	FLACUL ALF	EMMC DWDEN	CDI1 CLIV	LCDC_D23				1.0		4	0 4	,	
R10	MC_PWREN/SPI1_CLK/LC DC_D23_M1	GPIO3_B3	FLASH_ALE	EMMC_PWREN	SPI1_CLK	_M1				I/O	I	down	8mA	√	
	GPIO3_B4/FLASH_RDY/I2														
W12	C3_SDA_M1/SPI1_MOSI/	GPIO3_B4	FLASH_RDY	I2C3_SDA_M1	SPI1_MOS	UART3_RX				I/O	I	up	8mA	√	
	UART3_RX				I										
	GPIO3_B5/FLASH_CSN0/I		FLASH_CSN		SPI1_CSN										
T12	2C3_SCL_M1/SPI1_CSN0/	GPIO3_B5	0	I2C3_SCL_M1	0	UART3_TX				I/O	I	up	8mA	√	
	UART3_TX														
J19	GPIO4_A0/SDIO_D0/MAC	GPIO4_A0	SDIO_D0	MAC_RXER_M1						I/O	I	up	2mA	√	
	_RXER_M1														
J17	GPIO4_A1/SDIO_D1/MAC _RXDV_M1	GPIO4_A1	SDIO_D1	MAC_RXDV_M1						I/O	I	up	2mA	√	
G18	GPIO4_A2/SDIO_D2/MAC	GPIO4_A2	SDIO_D2	MAC_RXD0_M1						I/O	т	un	2mA	√	
G18	_RXD0_M1	GP104_A2	SDIO_D2	MAC_RXDU_MI						1/0	I	up	ZMA	V	
G17	GPIO4_A3/SDIO_D3/MAC _RXD1_M1	GPIO4_A3	SDIO_D3	MAC_RXD1_M1						I/O	I	up	2mA	√	
	GPIO4_A4/SDIO_CMD/MA			110											VCCIO4
H18	C_TXD0_M1	GPIO4_A4	SDIO_CMD	MAC_TXD0_M1						I/O	I	up	2mA	√	
J18	GPIO4_A5/SDIO_CLK/MA	GPIO4_A5	SDIO_CLK	MAC_TXD1_M1						I/O	I	down	2mA	√	
710	C_TXD1_M1	OI 104_A3		L'AC_IADI_HI						1,0	1	down	ZIIIA	v	
K19	GPIO4_A6/UART4_CTSN	GPIO4_A6	UART4_CTS N							I/O	I	up	2mA	√	
K18	GPIO4_A7/UART4_RTSN	GPIO4_A7	UART4_RTS N							I/O	I	up	2mA	√	

Pin	Pin Name	Func1	Func2	Func3	Func4	Func5	Func6	Func7	Func8	Pad	Def	Pull	Drive	INT	DIE Power
Pill	Fill Name	FullCI	FullC2	ruics	ruiic4	FullC3	FullCo			Type①	3	Pull	Strength2	1141	Domain
F17	GPIO4_B0/UART4_RX	GPIO4_B0	UART4_RX						_	I/O	I	up	2mA	√	
J16	GPIO4_B1/UART4_TX	GPIO4_B1	UART4_TX							I/O	I	up	2mA	√	
G16	GPIO4_B2	GPIO4_B2								I/O	I	down	2mA	$\checkmark$	
F19	GPIO4_B3	GPIO4_B3								I/O	I	down	2mA	√	
H16	GPIO4_B4/I2S0_2CH_MCL	GPIO4_B4	I2S0_2CH_M	MAC_CLK_M1						I/O	ı	down	2m /	√	
пто	K/MAC_CLK_M1	GP104_b4	CLK	MAC_CLK_MI						1/0	1	down	2mA	V	
F18	GPIO4_B5/I2S0_2CH_SCL	CDIO4 BE	I2S0_2CH_S	MAC MDC M1						I/O	т	down	2m1	√	
LIO	K/MAC_MDC_M1	GPIO4_B5	CLK	MAC_MDC_M1						1/0	I	down	2mA	V	
J15	GPIO4_B6/I2S0_2CH_LRC	GPIO4_B6	I2S0_2CH_L	MAC_MDIO_M1						I/O	I	down	2mA	<b>√</b>	
113	K_TX/MAC_MDIO_M1	GP104_B0	RCK_TX	MAC_MDIO_MI						1/0	1	down	ZIIIA	V	
H15	GPIO4_B7/I2S0_2CH_SD	GPIO4_B7	I2S0_2CH_S	MAC_TXEN_M1						I/O	ı	down	2mA	√	
птэ	O/MAC_TXEN_M1	GP104_B/	DO	MAC_IXEN_MI						1/0	1	down	ZIIIA	V	
H14	GPIO4_C0/I2S0_2CH_SDI	GPIO4 C0	I2S0_2CH_S							I/O	ī	down	2mA	<b>√</b>	
1114	GP104_C0/1230_2C11_3D1	GP104_C0	DI							1/0	1	down	ZIIIA	V	
B17	GPIO4_D0/SDMMC_D0	GPIO4_D0	SDMMC_D0	PMU_ST0						I/O	I	up	8mA	$\checkmark$	
A17	GPIO4_D1/SDMMC_D1	GPIO4_D1	SDMMC_D1	PMU_ST1						I/O	I	up	8mA	$\checkmark$	
B15	GPIO4_D2/SDMMC_D2/UA	GPIO4_D2	SDMMC_D2	UART2_RX_M1	PMU_ST2					I/O	,	215	8mA	√	
B13	RT2_RX_M1	GP104_D2	SDMMC_D2	UARTZ_RX_MI	FI10_312					1/0	1	up	оппа	V	
A15	GPIO4_D3/SDMMC_D3/UA	GPIO4_D3	SDMMC_D3	UART2_TX_M1	PMU_ST3					I/O	<sub>T</sub>	un	8mA	√	
AIS	RT2_TX_M1	GP104_D3	SDMMC_D3	UARTZ_TX_MI	FN0_515					1/0	1	up	оппа	V	VCCIO5
C16	GPIO4_D4/SDMMC_CMD	GPIO4_D4	SDMMC_CM	PMU_ST4						I/O	ı	up	8mA	√	
C16	GPIO4_D4/SDMMC_CMD	GP104_D4	D	PMU_514						1/0	1	ир	оппа	V	
B16	GPIO4_D5/SDMMC_CLK	GPIO4_D5	SDMMC_CLK	PMU_DEBUGTX						I/O	I	down	8mA	√	
D14	GPIO4_D6/SDMMC_PWRE	CDIO4 DC	SDMMC_PW							1/0		4	0 1	,	
B14	N	GPIO4_D6	REN							I/O		down	8mA	√	
F6	VERF	VREF													DDR_VDD
A19	ADC_IN0	ADC_IN0													CADADC
C18	ADC_IN2	ADC_IN2													SARADC

Pin	Pin Name	Func1	Func2	Func3	Func4	Func5	Func6	Func7	Func8	Pad	Def	Pull	Drive	INT	DIE Power
	T III Ruine	runci	rancz	Tunes	T dile-	runcs	Tunco			Type <sub>①</sub>	3	ı uıı	Strength <sub>2</sub>	21(1	Domain
B19	ADC_IN1	ADC_IN1													
A18	ADC_IN3	ADC_IN3													
B18	ADC_IN4	ADC_IN4							X						
D18	ADC_IN5	ADC_IN5													
B13	USB0_DP	USB0_DP								ŀ					
A13	USB0_DM	USB0_DM													
C12	USB_ID	USB_ID													USB
C14	USB_VBUS	USB_VBUS													USB
B12	USB1_DP	USB1_DP													
A12	USB1_DM	USB1_DM													
W18	CODEC_HPOUT_R	CODEC_HPOUT								А					
W19	CODEC_LINEOUT_R	CODEC_LINEO UT_R								А					
V18	CODEC_HPDET	CODEC_HPDET								Α					
W20	CODEC_LINEOUT_L	CODEC_LINEO UT_L			(					А					
Y19	CODEC_HPOUT_L	CODEC_HPOUT								A					Audio Codec
T18	CODEC_VCMH	CODEC_VCMH								Α					Audio Codec
U18	CODEC_MICBIAS2	CODEC_MICBI AS2								А					
Y18	CODEC_MICBIAS1	CODEC_MICBI AS1								А					
V19	CODEC_MICN1	CODEC_MICN1								Α					
V20	CODEC_MICP1	CODEC_MICP1								Α					
U20	CODEC_MICP2	CODEC_MICP2								Α					
U19	CODEC_MICN2	CODEC_MICN2			_					А			_		

Pin	Pin Name	Func1	Func2	Func3	Func4	Func5	Func6	Func7	Func8	Pad Type①	Def 3	Pull	Drive Strength②	INT	DIE Power Domain
R18	CODEC_VCM	CODEC_VCM								A					
P18	CODEC_MICP3	CODEC_MICP3								A					
P17	CODEC_MICN3	CODEC_MICN3							X	Α					
R20	CODEC_MICP4	CODEC_MICP4								А					
R19	CODEC_MICN4	CODEC_MICN4								Α					
P20	CODEC_MICP5	CODEC_MICP5								А					
P19	CODEC_MICN5	CODEC_MICN5								А					
N18	CODEC_MICP6	CODEC_MICP6								Α					
M18	CODEC_MICN6	CODEC_MICN6								Α					
N20	CODEC_MICP7	CODEC_MICP7								Α					
N19	CODEC_MICN7	CODEC_MICN7								Α					
M20	CODEC_MICP8	CODEC_MICP8								Α					
M19	CODEC_MICN8	CODEC_MICN8								Α					
T20	CODEC VCM LINEOUT	CODEC_VCM_L													
T20	CODEC_VCM_LINEOUT	INEOUT								A					

#### Notes:

 $^{\textcircled{0}^{:}}$  Pad types: I = input, O = output, I/O = input/output (bidirectional) AP = Analog Power, AG = Analog Ground DP = Digital Power, DG = Digital Ground A = Analog

@: Output Drive Unit is mA, only Digital IO has drive value;

③: Reset state: I = input, O = output;

# 2.8 IO Pin Name Description

This sub-chapter will focus on the detailed function description of every pins based on different interface.

Table 2-6 IO function description list

Interface	Pin Name	Direction	on description list  Description
	XIN_24M	I	Clock input of 24MHz crystal
	XOUT_24M	0	Clock output of 24MHz crystal
	NPOR	I	Chip hardware reset
	TVSS	I	Chip test mode enable
	NPOR_BYPASS	I	Chip internal NPOR module bypass control signal
	REF_CLKOUT	0	REF Clock Output for external function module
	TEST_CLKOUT	0	Chip internal clock output for measurement
Misc	PMIC_SLEEP	0	Chip low power mode output indication signal
	TSADC_SHUT	0	Chip high temperature output indication signal
			32K RTC clock
			If configured as input, rtc clock is provided
	RTC_CLK	I/O	from external circuit;
			If configured as output, rtc clock is provided
			from internal circuit of chip;
	PMU_ST <i>i</i> ( <i>i</i> =0~4)	0	Chip low power mode state output signal
	PMU_DEBUGTX	0	Chip low power mode state output signal

Interface	Pin Name	Direction	Description
CWI DD	JTAG_TCK	I	SWD interface clock input
SWJ-DP	JTAG_TMS	I/O	SWD interface data input/output

Interface	Pin Name	Direction	Description
	SDMMC_CLK	0	sdmmc card clock
	SDMMC CMD	1/0	sdmmc card command output and response
SD/MMC	SDMMC_CMD	I/O	input
Host	SDMMC_D[i]	1/0	admine cord data input and output
Controller	( <i>i</i> =0~3)	I/O	sdmmc card data input and output
	CDMMC DET	т	sdmmc card detect signal, 0 represents
	SDMMC_DET	1	presence of card

Interface	Pin Name	Direction	Description
	SDIO_CLK	0	sdio card clock
SDIO Host	SDIO_CMD	I/O	sdio card command output and response input
Controller	SDIO_D[i]	1/0	sdio card data input and output
	( <i>i</i> =0~3)	I/O	

Interface	Pin Name	Direction	Description
	EMMC_CLK	0	emmc card clock
eMMC	EMMC_CMD	I/O	emmc card command output and response
Interface			input
Interrace	EMMC_D[i]	I/O	anne and data incut and autout
	( <i>i</i> =0~7)		emmc card data input and output

Interface	Pin Name	Direction	Description
	FLASH_ALE	0	Flash address latch enable signal
	FLASH_CLE	0	Flash command latch enable signal
	FLASH_WRN	0	Flash write enable signal
Nand Flash	FLASH_RDN	0	Flash read enable signal
Interface	FLASH_Di(i=0~7)	I/O	Flash data input/output signal
	FLASH_RDY	I	Flash ready/busy signal
	FLASH_CSNi(i=0)	0	Flash chip enable signal for chip i, i=0

Interface	Pin Name	Direction	Description	
	SFC_CLK	0	sfc serial clock	
SFC Controller	SFC_CSNi(i=0)	0	sfc chip select signal, low active	
	SFC_SIOi(i=0~3)	I/O	sfc serial data input/output signal	

Interface	Pin Name	Direction	Description
	1000 0011		LCDC RGB interface display clock out, MCU i80
	LCDC_DCLK	0	interface RS signal
	LCDC VSYNC	0	LCDC RGB interface vertical sync pulse, MCU
	LCDC_VSTNC		i80 interface CSN signal
LCDC	LDCD_HSYNC	0	LCDC RGB interface horizontal sync pulse, MCU
			i80 interface WEN signal
	LCDC_DEN	0	LCDC RGB interface data enable, MCU i80
			interface REN signal
	LCDC_Di(i=0~23)	0	LCDC data output

Interface	Pin Name	Direction	Description
	DDR_CLK	0	Active-high clock signal to the memory device.
	DDR_CLKN	0	Active-low clock signal to the memory device.
	DDR CKE	0	Active-high clock enable signal to the memory
	DDK_CKL	0	device
DDR	DDR CSiN (i=0)	0	Active-low chip select signal to the memory
Interface	DDR_CS/N (/=0)	O	device.
	DDR RASN	0	Active-low row address strobe to the memory
	DDR_RASIN	U	device.
	DDR CASN	0	Active-low column address strobe to the
	DDR_CASIN	U	memory device.

Interface	Pin Name	Direction	Description
	DDD WEN	0	Active-low write enable strobe to the memory
	DDR_WEN	O	device.
	DDR_BA <i>i</i> ( <i>i</i> =0,1,2)	0	Bank address signal to the memory device.
	DDR_Ai(i=0~14)	0	Address signal to the memory device.
	DDR_DQ <i>i</i> ( <i>i</i> =0~15)	I/O	Bidirectional data line to the memory device.
	DDR DOS/(i=01)	1/0	Active-high bidirectional data strobes to the
	DDR_DQS <i>i</i> (i=0~1)	I/O	memory device.
	DDR DOS $iN(i=0\sim1)$	1/0	Active-low bidirectional data strobes to the
	DDR_DQS/N(/=0~1)	I/O	memory device.
	DDR_DMi(1=0~1)	0	Data mask signal to the memory device.
	DDR_ODTi(i=0)	0	On-Die Termination output signal.
	DDR_RESET	0	Reset signal to the memory device.
	VREF	I	VREF of DDR DIE, only for RK3308H-S

Interface	Pin Name	Direction	Description
	I2S0_8CH_MCLK	0	I2S/PCM/TDM clock source
	I2S0_8CH_SCLK_RX	I/O	I2S/PCM/TDM receiving serial clock
	I2S0_8CH_SCLK_TX	I/O	I2S/PCM/TDM transmitting serial clock
I2S_8CH_0	I2S0_8CH_LRCK_RX	I/O	I2S/PCM/TDM left & right channel signal for receiving serial data
Controller	I2S0_8CH_LRCK_TX	I/O	I2S/PCM/TDM left & right channel signal for transmitting serial data
	I2S0_8CH_SDI <i>i</i> ( <i>i</i> =1~3)	T	I2S/PCM/TDM serial data input
	I2S0_8CH_SDO <i>i</i> ( <i>i</i> =1~3)	0	I2S/PCM/TDM serial data output

Interface	Pin Name	Direction	Description
	I2S1_8CH_MCLK_M <i>i</i> ( <i>i</i> =0~1)	0	I2S/PCM/TDM clock source
	I2S1_8CH_SCLK_RX_M <i>i</i> ( <i>i</i> =0~1)	I/O	I2S/PCM/TDM receiving serial clock
	I2S1_8CH_SCLK_TX_M <i>i</i> ( <i>i</i> =0~1)	I/O	I2S/PCM/TDM transmitting serial clock
	I2S1_8CH_LRCK_RX_M <i>i</i> ( <i>i</i> =0~1)	I/O	I2S/PCM/TDM left & right channel signal for receiving serial data
I2S_8CH_1	I2S1_8CH_LRCK_TX_M <i>i</i> ( <i>i</i> =0~1)	I/O	I2S/PCM/TDM left & right channel signal for transmitting serial data
Controller	I2S1_8CH_SD00_M <i>i</i> ( <i>i</i> =0~1)	0	I2S/PCM/TDM serial data output
	I2S1_8CH_SD01_SDI3_M <i>i</i> ( <i>i</i> =0~1)	I/O	I2S/PCM/TDM serial data input/output
	I2S1_8CH_SDO2_SDI2_M <i>i</i> ( <i>i</i> =0~1)	I/O	I2S/PCM/TDM serial data input/output
	I2S1_8CH_SD03_SDI1_M <i>i</i> ( <i>i</i> =0~1)	I/O	I2S/PCM/TDM serial data input/output
	I2S1_8CH_SDI0_M <i>i</i> ( <i>i</i> =0~1)	I	I2S/PCM/TDM serial data input

Interface	Pin Name	Direction	Description
	I2S0_2CH_MCLK	0	I2S/PCM clock source
I2S 2CH 0	I2S0_2CH_SCLK	I/O	I2S/PCM serial clock
Controller	I2S0_2CH_LRCK_TX	I/O	I2S/PCM left & right channel signal for transmitting serial data
	I2S0_2CH_SDI	I	I2S/PCM serial data input

Interface	Pin Name	Direction	Description
	I2S0_2CH_SDO	0	I2S/PCM serial data output

Interface	Pin Name	Direction	Description
	PDM_8CH_CLK_Mi(i=0~1)	0	PDM sampling clock
	PDM_8CH_CLK_M_M2	0	PDM sampling clock
PDM	PDM_8CH_CLK_S_M2	0	PDM sampling clock
	PDM_8CH_SDI0_Mi(i=0~2)	I	PDM data
	PDM_8CH_SDI1_Mi(i=0~2)	I	PDM data
	PDM_8CH_SDI2_M <i>i</i> ( <i>i</i> =0~2)	I	PDM data
	PDM_8CH_SDI3_M <i>i</i> ( <i>i</i> =0~2)	I	PDM data

Interface	Pin Name	Direction	Description
SPI	SPI <i>i</i> _CLK( <i>i</i> =0~2)	I/O	SPI serial clock
	SPI <i>i</i> _CSN0( <i>i</i> =0~2)	I/O	SPI chip select signal, low active
	SPIi_MISO(i=0~2)	I/O	SPI serial data input/output
	SPIi_MOSI(i=0~2)	I/O	SPI serial data input/output

Interface	Pin Name	Direction	Description
	PWM0	I/O	Pulse Width Modulation input and output
	PWM1	I/O	Pulse Width Modulation input and output
	PWM2	I/O	Pulse Width Modulation input and output
	DWW3	I/O	Pulse Width Modulation input and output, used
	PWM3		for IR application recommended
	PWM4	I/O	Pulse Width Modulation input and output
PWM	PWM5	I/O	Pulse Width Modulation input and output
	PWM6	I/O	Pulse Width Modulation input and output
	PWM7	I/O	Pulse Width Modulation input and output
	PWM8	I/O	Pulse Width Modulation input and output
0	PWM9	I/O	Pulse Width Modulation input and output
	PWM10	I/O	Pulse Width Modulation input and output
	PWM11	I/O	Pulse Width Modulation input and output

Interface	Pin Name	Direction	Description
I2C	I2Ci_SDA	I/O	I2C data
	( <i>i</i> =0,1,2,3)		
	I2Ci_SCL	I/O	IC class
	( <i>i</i> =0,1,2,3)		I2C clock

Interface	Pin Name	Direction	Description
UART	UART <i>i_</i> RX	I	UART serial data input
	( <i>i</i> =0,1,2,3,4)		

Interface	Pin Name	Direction	Description
	UART <i>i</i> _TX ( <i>i</i> =0,1,2,3,4)	0	LIADT carial data output
		0	UART serial data output
	UARTi_CTSN	т.	HART class to a seed on a decreated in sect
	( <i>i</i> =0,1,4)	1	UART clear to send modem status input
	UARTi_RTSN	0	LIADT medam control requires to cond cutout
	( <i>i</i> =0,1,4)	0	UART modem control request to send output

Interface	Pin Name	Direction	Description
OWIDE	OWIRE_Mi	1/0	1 wire bus data
OWIRE	( <i>i</i> =0,1,2)	I/O	1-wire bus data

Interface	Pin Name	Direction	Description
	MAC_CLK	I/O	MAC REC_CLK output or external clock input
	MAC_MDC	0	MAC management interface clock
	MAC_MDIO	I/O	MAC management interface data
MAG	$MAC_TXDi(i=0\sim1)$	0	MAC TX data
MAC	$MAC_RXDi(i=0\sim1)$	I	MAC RX data
	MAC_TXEN	0	MAC TX data enable
	MAC_RXER	I	MAC RX error signal
	MAC_RXDV	I	MAC RX data valid signal

Interface	Pin Name	Direction	Description
	USB0_DP	I/O	USB 2.0 Data signal DP
	USB0_DM	I/O	USB 2.0 Data signal DM
	USB1_DP	I/O	USB 2.0 Data signal DP
USB 2.0	USB1_DM	I/O	USB 2.0 Data signal DM
	USB_VBUS	I	Insert detect when act as USB device
	USB_ID	I	USB Mini-Receptacle Identifier

Interface	Pin Name	Direction	Description
	CODEC_HPOUT_R	0	Right DAC channel headphone output
	CODEC_HPOUT_L	0	Left DAC channel headphone output
	CODEC_LINEOUT_R	0	Right DAC channel line output
	CODEC_LINEOUT_L	0	Left DAC channel line output
Audio	CODEC_MICBIAS1	0	Microphone bias voltage1
Audio Codec	CODEC_MICBIAS2	0	Microphone bias voltage2
	CODEC_VCMH	0	Reference voltage output for microphone bias voltage
	CODEC_MICN1	I	ADC channel 1 Microphone input
	CODEC_MICP1	I	ADC channel 1 Microphone input
	CODEC_MICN2	I	ADC channel 2 Microphone input

Interface	Pin Name	Direction	Description
	CODEC_MICP2	I	ADC channel 2 Microphone input
	CODEC_MICN3	I	ADC channel 3 Microphone input
	CODEC_MICP3	I	ADC channel 3 Microphone input
	CODEC_MICN4	I	ADC channel 4 Microphone input
	CODEC_MICP4	I	ADC channel 4 Microphone input
	CODEC_MICN5	I	ADC channel 5 Microphone input
	CODEC_MICP5	I	ADC channel 5 Microphone input
	CODEC_MICN6	I	ADC channel 6 Microphone input
	CODEC_MICP6	I	ADC channel 6 Microphone input
	CODEC_MICN7	I	ADC channel 7 Microphone input
	CODEC_MICP7	I	ADC channel 7 Microphone input
	CODEC_MICN8	I	ADC channel 8 Microphone input
	CODEC_MICP8	I	ADC channel 8 Microphone input
	CODEC_VCM	0	Reference voltage output
	CODEC_HPDET	I	Headphone insertion detection
	CODEC_VCM_LINEO UT	0	Reference voltage output

# **2.9 IO Type**

The following list shows IO type except DDR IO and all of Power/Ground IO.

Table 2-7 IO Type List

Туре	Diagram	Description	Pin Name
A	POC VREF HVPS VDFS DVDD VDD  VDD  VDD  VDD  VDD  VDD  VDD	Crystal Oscillator with high enable	XIN_24M / XOUT_24M
В	POC HVPS VREF VDFS  VDD DVDD  PAD  FAD  FAD  FAD  FAD  FAD  FAD  F	Tri-state output pad with input, which pull-up/ pull-down, slew rate and drive strength is configurable	Pad of digital GPIO

## **Chapter 3 Electrical Specification**

### 3.1 Absolute Ratings

The below table provides the absolute ratings.

Absolute maximum ratings specify the values beyond which the device may be damaged permanently. Long-term exposure to absolute maximum ratings conditions may affect device reliability.

Table 3-1 Absolute ratings

	3001446 14411160			
Parameters	Related Power Group	Min	Max	Unit
Supply voltage for CPU	CORE_VDD	0	1.30	V
Supply voltage for Logic	LOGIC_VDD	0	1.10	V
0.9V supply voltage		0	1.00	٧
1.8V supply voltage		0	1.98	V
3.3V supply voltage		0	3.63	V
Supply voltage for DDR IO	. (7	0	1.89	V
Storage Temperature	Tstg	-40	125	°C
Max Conjunction Temperature	Ťj	-40	125	°C

# **3.2 Recommended Operating Condition**

Following table describes the recommended operating condition.

Table 3-2 Recommended operating condition

Parameters	Symbol	Min	Тур	Max	Unit
Voltage for CPU	CORE_VDD	TBD	0.90	TBD	V
Voltage for Logic	LOGIC_VDD	0.81	0.90	1.00	V
Digital CDIO Davier (2.3)//1.9\/)	VCCIO0,VCCIO1,VCCIO2,	2.97	3.30	3.63	V
Digital GPIO Power (3.3V/1.8V)	VCCIO3,VCCIO4,VCCIO5	1.62	1.80	1.98	V
DDR2 IO power	DDR_VDD	1.71	1.80	1.89	V
DDR3 IO power	DDR_VDD	1.425	1.50	1.575	V
DDR3L IO Power	DDR_VDD	1.283	1.35	1.418	V
LPDDR2 IO Power	DDR_VDD	1.14	1.20	1.26	V
OTP Analog Power	OTP_VCC_1V8	1.62	1.80	1.98	V
PLL Analog Power(0.9V)	PLL_AVDD_0V9	0.81	0.90	1.00	V
PLL Analog Power(1.8V)	PLL_AVDD_1V8	1.62	1.80	1.98	V
SARADC Analog Power	SADC_AVDD_1V8	1.62	1.80	1.98	V
USB 2.0 OTG/Host Analog	USB_VDD_0V9	0.81	0.90	1.00	V
Power (0.9V)					
USB 2.0 OTG/Host Analog	USB AVDD 1V8	1.62	1.80	1.98	V
Power (1.8V)	00555_210		2.00	2.50	-
USB 2.0 OTG/Host Analog	USB AVDD 3V3	2.97	3.30	3.63	V
Power (3.3V)	030_AVD_3V3	2.37	3.30	5.05	V
Audio Codec Analog Power	CODEC AVDD 1V8	1.62	1.80	1.98	V
(1.8V)	CODEC_AVDD_1V0	1.02	1.00	1.90	V

Parameters	Symbol	Min	Тур	Max	Unit
Audio Codec Analog Power	CODEC AVDD 2V2	2.97	3.30	3.63	V
(3.3V)	CODEC_AVDD_3V3	2.97	3.30	3.03	V
OSC input clock frequency		N/A	24	N/A	MHz
Max CPU frequency of A35		N/A	N/A	1.1	GHz
Ambient Operating Temperature	T <sub>A</sub>	0	25	85	°C

Notes:

## 3.3 DC Characteristics

Table 3-3 DC Characteristics

	Parameters	Symbol	Min	Тур	Max	Unit
	Input Low Voltage	Vil	NA	NA	0.8	V
	Input High Voltage	Vih	2	NA	3.3+0.3	>
Digital GPIO	Output Low Voltage	Vol	NA	NA	0.4	>
@3.3V	Output High Voltage	Voh	2.4	NA	NA	>
	Pullup Resistor	Rpu	27	33	44	Kohm
	Pulldown Resistor	Rpd	31	88	221	Kohm
	Input Low Voltage	Vil	NA	NA	1.8x0.35	V
	Input High Voltage	Vih	1.8x0.65	NA	1.8 + 0.3	V
Digital GPIO	Output Low Voltage	Vol	NA	NA	0.45	V
@1.8V	Output High Voltage	Voh	1.8-0.45	NA	NA	V
	Pullup Resistor	Rpu	14	20	37	Kohm
	Pulldown Resistor	Rpd	23	49	122	Kohm

	Parameters	Symbol	Min	Тур	Max	Unit
	Input High Voltage	Vih_ddr	VREF + 0.13	NA	DDR_VDD	V
DDR IO @	Input Low Voltage	Vil_ddr	VSS	NA	VREF - 0.13	V
LPDDR2 mode	Output High Voltage	Voh_ddr	VREF + 0.13	NA	DDR_VDD	V
	Output Low Voltage	Vol_ddr	VSS	NA	VREF-0.13	V
	Input High Voltage	Vih_ddr	VREF + 0.13	NA	DDR_VDD	V
DDR IO @	Input Low Voltage	Vil_ddr	VSS	NA	VREF - 0.13	V
DDR2 mode	Output High Voltage	Voh_ddr	VREF + 0.13	NA	DDR_VDD	V
	Output Low Voltage	Vol_ddr	VSS	NA	VREF-0.13	V
	Input High Voltage	Vih_ddr	VREF + 0.10	NA	DDR_VDD	V
DDR IO @	Input Low Voltage	Vil_ddr	VSS	NA	VREF - 0.10	V
@DDR3 mode	Output High Voltage	Voh_ddr	VREF + 0.10	NA	DDR_VDD	V
	Output Low Voltage	Vol_ddr	VSS	NA	VREF - 0.10	V
	Input High Voltage	Vih_ddr	VREF + 0.09	NA	DDR_VDD	V
DDR IO @	Input Low Voltage	Vil_ddr	VSS	NA	VREF - 0.09	V
@DDR3L mode	Output High Voltage	Voh_ddr	VREF + 0.09	NA	DDR_VDD	V
	Output Low Voltage	Vol_ddr	VSS	NA	VREF - 0.09	V

① Symbol name is same as the pin name in the io descriptions

#### 3.4 Electrical Characteristics for General IO

Table 3-4 Electrical Characteristics for Digital General IO

14010 0 1 2100011041 01141 40001101101 2181141 40110141 10							
Pa	arameters	Symbol	Test condition	Min	Тур	Max	Unit
Digital CDIO	Input leakage current	Ii	Vin = 3.3V or 0V	NA	NA	10	uA
Digital GPIO @3.3V	Tri-state output leakage current	Ioz	Vout = 3.3V or 0V	NA	NA	10	uA
Digital GPIO	Input leakage current	Ii	Vin = 1.8V or 0V	NA	NA	10	uA
@1.8V	Tri-state output leakage current	Ioz	Vout = 1.8V or 0V	NA	NA	10	uA

### 3.5 Electrical Characteristics for PLL

Table 3-5 Electrical Characteristics for PLL

	Parameters	Symbol	Test condition	Min	Тур	Max	Unit
	Input clock frequency(Int)	Fin	Fin = FREF @1.8V/0.9V	1		1800	MHz
	Input clock frequency(Frac)	F <sub>in</sub>	Fin = FREF @1.8V/0.9V	10		1800	MHz
	VCO operating range	F <sub>vco</sub>	Fvco = Fref * FBDIV @1.8V/0.9V	900		3600	MHz
	Output clock frequency	F <sub>out</sub>	Fout = Fvco/POSTDIV @1.8V/0.9V	18		3600	MHz
PLL	Lock time	Tit	FREF=24M,REFDIV=1 @1.8V/0.9V		250	500	Input clock cycles
	VDDHV current consumption	2	Fvco = 1000MHz, @1.8V Current scale as (Fvco/1GHz) <sup>1.5</sup>		0.6	0.65	mA
	VDD Current consumption		VDD =0.9V		0.9	1.08	uA/MHz
	Power consumption (power-down mode)		PD=HIGH, @27 ℃		38		uA

#### Notes:

- ① REFDIV is the input divider value;
- ② FBDIV is the feedback divider value;
- ③ POSTDIV is the output divider value

#### 3.6 Electrical Characteristics for USB 2.0 Interface

Table 3-6 Electrical Characteristics for USB 2.0 Interface

Parameters	Symbol	Test condition	Min	Тур	Max	Unit
		Transmitter				
High input level	VIH		0.6			V
Low input level	VIL				0.2	V
Output resistance	ROUT	Classic mode (Vout = 0 or 3.3V)	40.5	45	49.5	ohms

Parameters	Symbol	Test condition	Min	Тур	Max	Unit
		HS mode (Vout = 0 to 800mV)	40.5	45	49.5	ohms
Output Capacitance	COUT	seen from D+ or D-			3	pF
Output Common Mode Voltage	VM	Classic (LS/FS) mode	1.45	1.65	1.85	V
Output Common Mode Voltage	VIVI	HS mode	0.175	0.2	0.225	V
		Classic (LS/FS); Io=0mA	2.97	3.3	3.63	V
Differential output signal high	VOH	Classic (LS/FS); Io=6mA	2.2	2.7		V
		HS mode; Io=0mA	360	400	440	mV
		Classic (LS/FS); Io=0mA	-0.33	0	0.33	V
Differential output signal low	VOL	Classic (LS/FS); Io=6mA		0.3	0.8	V
		HS mode; Io=0mA	-40	0	40	mV
		Receiver			10	
Danis and a side in the	DCENC	Classic mode		+-250		mV
Receiver sensitivity	RSENS	HS mode		+-25		mV
		Classic mode	0.8	1.65	2.5	V
Receiver common mode	RCM	HS mode (differential and squelch comparator)	0.1	0.2	0.3	V
		HS mode (disconnect comparator)	0.5	0.6	0.7	V
Input capacitance		(seen at D+ or D-)			3	pF
Squelch threshold			100	112	150	mV
Disconnect threshold			570	590	625	mV
High output level	VOH		2.8	3.3		V
Low output level	VOL			0	0.3	V

# 3.7 Electrical Characteristics for TSADC

Table 3-7 Electrical Characteristics for TSADC

Parameters	Symbol	Test condition	Min	Тур	Max	Unit
Temperature Resolution				+/-5		$^{\circ}$
Temperature Range			-20		120	ů
Analog power	IAVDD	Fs= 1KS/s		250		uA
Digital power	IVDD	Fs= 1KS/s		6		uA
Clock Frequency	Fclk	Fclk			1	KHz
Power Down Current from Analog	IAVDD	Power down		1		uA
Power Down Current from Digital	IVDD	Power down		3		uA

### 3.8 Electrical Characteristics for SARADC

Table 3-8 Electrical Characteristics for SARADC

Parameters	Symbol	Test condition	Min	Тур	Max	Units
Resolution				10		bit
Differential Nonlinearity	DNL		-1		+1	LSB

Parameters	Symbol	Test condition	Min	Тур	Max	Units
Integral Nonlinearity	INL		-1		+1	LSB
Input Voltage Range	VIN		0.01		0.99	AVDD
Input Capacitance	CIN			3.2		pF
Sampling Rate	fs				1	MS/s
Analog power	IAVDD	Fs= 1MS/s		368		uA
Digital power	IVDD	Fs= 1MS/s		6		uA
Power Down Current from Analog	IAVDD	Power down		17		uA
Power Down Current from Digital	IVDD	Power down		1	10	uA

# 3.9 Electrical Characteristics for Audio Codec

Table 3-9 Electrical Characteristics for Audio Codec

Parameters	Symbol	Test condition	Min	Тур	Max	Unit	
Microphone Bias							
MICBIAS1 Voltage	V(MICBIAS1)		0.5* CODEC_AVDD_ 3V3		0.85* CODEC_AVDD_3 V3	V	
MICBIAS2 Voltage	V(MICBIAS2)		0.5* CODEC_AVDD_ 3V3		0.85* CODEC_AVDD_3 V33	V	
Bias Step Size			~ O '	0.05* CODEC_AVDD_3 V3		V	
Bias Current	I(MICBIAS)				3	mA	
		Microp	ohone Gain Boost F	PGA			
Programmable Gain	G(BST)		0		20	dB	
Gain Step Size				20		dB	
Input	RIN	G(BST)=0db		44		Kohm	
Resistance		G(BST)=20db		8		Kohm	
Input Capacitance	CIN			10		pF	
		1	ALC PGA	1		I	
Programmable Gain	G(ALC)		-18		28.5	dB	
Gain Step Size				1.5		dB	
			ADC			,	
Signal to Noise Ratio	SNR	A-weighted		92		dB	
Total Harmonic Distortion	THD	(-3dBFS) input		-80		dB	
Channel Separation				80		dB	
Power Supply Rejection	PSRR	1KHZ		80		dB	
A/D Digital Filter Pass Band Ripple			0.1	0.125	0.125	(+/-)dB	
Output Driver							
Programmable Gain	G(DRV)		-39		6	dB	
Gain Step Size				1.5		dB	
Output Resistance	ROUT			1		Kohm	

Parameters	Symbol	Test condition	Min	Тур	Max	Unit
Output Capacitance	COUT			20		pF
Power Supply Rejection	PSRR	1KHZ		55		dB
			Line Output			
Signal to Noise Ratio	SNR	A-weighted		93		dB
Total Harmonic Distortion	THD	(-3dBFS) output 600ohm load		-84		dB
Channel Separation				85		dB
		He	eadphone Output			
Signal to Noise Ratio	SNR	A-weighted		93		dB
Total Harmonic	THD	16ohm load Po=18mW		-70		dB
Distortion	IIID	32ohm load Po=9mW		-75		dB
Power Consumption						
Standby				0.01 @ CODEC_AVDD_1 V8		mA
Mono Recording				2.5 @ CODEC_AVDD_1 V8		mA
Mono Playback				3 @ CODEC_AVDD_1 V8		mA

## **Chapter 4 Thermal Management**

#### 4.1 Overview

For reliability and operability concerns, the absolute maximum junction temperature has to be below  $125^{\circ}$ C.

### 4.2 Package Thermal Characteristics

RK3308B-S

Table 4-1 provides the RK3308B-S thermal resistance characteristics for the package used on the SoC. The resulting simulation data for reference only, please prevail in kind test.

Table 4-1 RK3308B-S Thermal Resistance Characteristics

Parameter	Symbol	Typical	Unit
Junction-to-ambient thermal resistance	$ heta_{JA}$	45	(°C/W)
Junction-to-board thermal resistance	$ heta_{JB}$	35	(°C/ <b>W</b> )
Junction-to-case thermal resistance	$\theta_{JC}$	15	(°C/W)

Note: The testing PCB is 4 layers, 101.6mmx114.3mm, 1.6mm thickness, Ambient temperature is 25 °C.

#### RK3308H-S

Table 4-2 provides the RK3308H-S thermal resistance characteristics for the package used on the SoC. The resulting simulation data for reference only, please prevail in kind test.

Table 4-2 RK3308H-S Thermal Resistance Characteristics

Parameter	Symbol	Typical	Unit
Junction-to-ambient thermal resistance	$ heta_{JA}$	44	(°C/ <b>W</b> )
Junction-to-board thermal resistance	$\theta_{JB}$	34	(°C/W)
Junction-to-case thermal resistance	$\theta_{JC}$	14	(°C/W)

Note: The testing PCB is 4 layers, 101.6mmx114.3mm, 1.6mm thickness, Ambient temperature is 25 °C.